Quad, 16-Bit, 125 MSPS, JESD204B 1.8 V Analog-to-Digital Converter

## Data Sheet

## FEATURES

SNR $=\mathbf{7 9 . 9} \mathbf{~ d B F S}$ at $\mathbf{1 6 ~ M H z}\left(\mathrm{V}_{\text {REF }}=1.4 \mathrm{~V}\right)$
$\mathrm{SNR}=\mathbf{7 8 . 1} \mathrm{dBFS}$ at $\mathbf{6 4 ~ M H z}\left(\mathrm{V}_{\text {REF }}=\mathbf{1 . 4} \mathrm{V}\right)$
SFDR $=\mathbf{8 6 ~ d B c ~ t o ~ N y q u i s t ~ ( ~} \mathrm{V}_{\text {ref }}=1.4 \mathrm{~V}$ )
JESD204B Subclass 1 coded serial digital outputs
Flexible analog input range: 2.0 V p-p to 2.8 V p-p
1.8 V supply operation

Low power: 197 mW per channel at 125 MSPS (two lanes)
DNL $= \pm \mathbf{0} .6$ LSB $\left(\mathrm{V}_{\text {Ref }}=1.4 \mathrm{~V}\right)$
$\mathrm{INL}= \pm 4.5 \mathrm{LSB}\left(\mathrm{V}_{\text {ReF }}=1.4 \mathrm{~V}\right)$
650 MHz analog input bandwidth, full power
Serial port control
Full chip and individual channel power-down modes
Built-in and custom digital test pattern generation
Multichip sync and clock divider
Standby mode

## APPLICATIONS

## Medical ultrasound and MRI

High speed imaging
Quadrature radio receivers

## Diversity radio receivers

Portable test equipment

## GENERAL DESCRIPTION

The AD9656 is a quad, 16-bit, 125 MSPS analog-to-digital converter (ADC) with an on-chip sample and hold circuit designed for low cost, low power, small size, and ease of use. The device operates at a conversion rate of up to 125 MSPS and is optimized for outstanding dynamic performance and low power in applications where a small package size is critical.

The ADC requires a single 1.8 V power supply and LVPECL-/ CMOS-/LVDS-compatible sample rate clock for full performance operation. An external reference or driver components are not required for many applications.
Individual channel power-down is supported and typically consumes less than 14 mW when all channels are disabled. The ADC contains several features designed to maximize flexibility and minimize system cost, such as a programmable output clock, data alignment, and digital test pattern generation. The available digital test patterns include built-in deterministic and pseudorandom patterns, along with custom user-defined test patterns entered via the serial port interface (SPI).


The AD9656 is available in an RoHS compliant, nonmagnetic, 56-lead LFCSP. It is specified over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
industrial temperature range.

## PRODUCT HIGHLIGHTS

1. It has a small footprint. Four ADCs are contained in a small, $8 \mathrm{~mm} \times 8 \mathrm{~mm}$ package.
2. An on-chip phase-locked loop (PLL) allows users to provide a single ADC sampling clock; the PLL multiplies the ADC sampling clock to produce the corresponding JESD204B data rate clock.
3. The configurable JESD204B output block supports up to 8.0 Gbps per lane.
4. JESD204B output block supports one, two, and four lane configurations.
5. Low power of 198 mW per channel at 125 MSPS, two lanes.
6. The SPI control offers a wide range of flexible features to meet specific system requirements.

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A. Tel: 781.329.4700 ©2013-2017 Analog Devices, Inc. All rights reserved. Technical Support

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## SPECIFICATIONS

DC SPECIFICATIONS, $\mathbf{V}_{\text {REF }}=\mathbf{1 . 4} \mathbf{V}$
AVDD $=1.8 \mathrm{~V}, \mathrm{DRVDD}=1.8 \mathrm{~V}, 2.8 \mathrm{~V}$ p-p full-scale differential input, 1.4 V reference, $\mathrm{A}_{\mathrm{IN}}=-1.0 \mathrm{dBFS}$, unless otherwise noted.
Table 1.

| Parameter ${ }^{1}$ | Temperature | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RESOLUTION |  |  | 16 |  | Bits |
| ACCURACY <br> No Missing Codes <br> Offset Error <br> Offset Matching <br> Gain Error <br> Gain Matching <br> Differential Nonlinearity (DNL) Integral Nonlinearity (INL) | Full <br> Full <br> Full <br> Full <br> Full <br> Full <br> Full | $\begin{aligned} & -0.1 \\ & 0 \\ & -2.0 \\ & 0 \\ & -0.95 \\ & -10.0 \end{aligned}$ | $\begin{aligned} & \text { Guaranteed } \\ & +0.14 \\ & 0.1 \\ & +2.1 \\ & 1.4 \\ & \pm 0.6 \\ & \pm 4.5 \end{aligned}$ | $\begin{aligned} & +0.5 \\ & 0.4 \\ & +6.0 \\ & 5.0 \\ & +2.54 \\ & +10.0 \\ & \hline \end{aligned}$ | $\begin{aligned} & \text { \% FSR } \\ & \text { \% FSR } \\ & \text { \% FSR } \\ & \text { \% FSR } \\ & \text { LSB } \\ & \text { LSB } \\ & \hline \end{aligned}$ |
| TEMPERATURE DRIFT Gain Error Offset Error | Full <br> Full |  | $\begin{aligned} & 12.3 \\ & -2 \end{aligned}$ |  | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| INTERNAL VOLTAGE REFERENCE <br> Output Voltage <br> Load Regulation at 1.0 mA Input Resistance | $\begin{aligned} & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \end{aligned}$ | 1.37 | $\begin{aligned} & 1.4 \\ & 4 \\ & 7.5 \end{aligned}$ | 1.41 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{mV} \\ & \mathrm{k} \Omega \end{aligned}$ |
| INPUT REFERRED NOISE $V_{\text {REF }}=1.4 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ |  | 2.1 |  | LSB rms |
| ANALOG INPUTS Differential Input Voltage Common-Mode Voltage Common-Mode Range Differential Input Resistance Differential Input Capacitance | Full <br> Full <br> $25^{\circ} \mathrm{C}$ <br> $25^{\circ} \mathrm{C}$ <br> $25^{\circ} \mathrm{C}$ | 0.7 | $\begin{aligned} & 2.8 \\ & 0.9 \\ & 2.6 \\ & 7 \end{aligned}$ | 1.1 | $\begin{aligned} & V p-p \\ & V \\ & V \\ & k \Omega \\ & p F \end{aligned}$ |
| POWER SUPPLY <br> AVDD <br> DVDD, DRVDD <br> SVDD <br> IAvdD (125 MSPS, Two Lanes) ${ }^{2}$ <br> Iovdo ( 125 MSPS, Two Lanes) ${ }^{2}$ <br> Idrvdd (125 MSPS, Two Lanes) ${ }^{2}$ | Full <br> Full <br> Full <br> Full <br> Full <br> Full | $\begin{aligned} & 1.7 \\ & 1.7 \\ & 1.7 \end{aligned}$ | $\begin{aligned} & 1.8 \\ & 1.8 \\ & \\ & 288 \\ & 67 \\ & 83 \end{aligned}$ | $\begin{aligned} & 1.9 \\ & 1.9 \\ & 3.6 \\ & 306 \\ & 72 \\ & 88 \end{aligned}$ | V <br> V <br> V <br> mA <br> mA <br> mA |
| TOTAL POWER CONSUMPTION <br> DC Input (125 MSPS, Four Channels onto Two Lanes) <br> Sine Wave Input ( 125 MSPS, Four Channels onto Two Lanes) ${ }^{2}$ <br> Power-Down Mode <br> Standby Mode ${ }^{3}$ | $\begin{aligned} & 25^{\circ} \mathrm{C} \\ & \text { Full } \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \end{aligned}$ |  | $\begin{aligned} & 706 \\ & 788 \\ & 14 \\ & 547 \end{aligned}$ | 839 | $\begin{gathered} \mathrm{mW} \\ \mathrm{~mW} \\ \mathrm{~mW} \\ \mathrm{~mW} \end{gathered}$ |

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## AD9656

DC SPECIFICATIONS, $\mathbf{V}_{\text {REF }}=\mathbf{1 . 0} \mathbf{V}$
$\mathrm{AVDD}=1.8 \mathrm{~V}, \mathrm{DRVDD}=1.8 \mathrm{~V}, 2.0 \mathrm{~V}$ p-p full-scale differential input, 1.0 V reference, $\mathrm{A}_{\mathrm{IN}}=-1.0 \mathrm{dBFS}$, unless otherwise noted.
Table 2.

| Parameter ${ }^{1}$ | Temperature | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RESOLUTION |  |  | 16 |  | Bits |
| ACCURACY <br> No Missing Codes <br> Offset Error <br> Offset Matching <br> Gain Error <br> Gain Matching <br> Differential Nonlinearity (DNL) Integral Nonlinearity (INL) | $\begin{aligned} & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \end{aligned}$ |  | Guaranteed 0.2 0.13 1.8 1.4 $\pm 0.6$ $\pm 6.0$ |  | $\begin{aligned} & \text { \% FSR } \\ & \text { \% FSR } \\ & \text { \% FSR } \\ & \text { \% FSR } \\ & \text { LSB } \\ & \text { LSB } \\ & \hline \end{aligned}$ |
| TEMPERATURE DRIFT Gain Error Offset Error | Full <br> Full |  | $\begin{aligned} & 6.3 \\ & -3 \end{aligned}$ |  | $\begin{aligned} & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{aligned}$ |
| INTERNAL VOLTAGE REFERENCE <br> Output Voltage <br> Load Regulation at 1.0 mA Input Resistance | $\begin{aligned} & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 1.0 \\ & 2 \\ & 7.5 \\ & \hline \end{aligned}$ |  | V <br> mV <br> k $\Omega$ |
| INPUT REFERRED NOISE $V_{\text {REF }}=1.0 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ |  | 2.7 |  | LSB rms |
| ANALOG INPUTS Differential Input Voltage Common-Mode Voltage Common-Mode Range Differential Input Resistance Differential Input Capacitance | Full <br> Full <br> $25^{\circ} \mathrm{C}$ <br> $25^{\circ} \mathrm{C}$ <br> $25^{\circ} \mathrm{C}$ | 0.5 | $\begin{aligned} & 2.0 \\ & 0.9 \\ & 2.6 \\ & 7 \end{aligned}$ | 1.3 | $\begin{aligned} & \text { V p-p } \\ & \text { V } \\ & \mathrm{V} \\ & \mathrm{k} \Omega \\ & \mathrm{pF} \\ & \hline \end{aligned}$ |
| POWER SUPPLY <br> AVDD <br> DVDD, DRVDD <br> SVDD <br> IAvdD ( 125 MSPS, Two Lanes) ${ }^{2}$ <br> Idvod (125 MSPS, Two Lanes) ${ }^{2}$ <br> Idrvdd (125 MSPS, Two Lanes) ${ }^{2}$ | Full <br> Full <br> Full <br> $25^{\circ} \mathrm{C}$ <br> $25^{\circ} \mathrm{C}$ <br> $25^{\circ} \mathrm{C}$ | $\begin{aligned} & 1.7 \\ & 1.7 \\ & 1.7 \end{aligned}$ | $\begin{aligned} & 1.8 \\ & 1.8 \\ & 276 \\ & 69 \\ & 83 \\ & \hline \end{aligned}$ | $\begin{aligned} & 1.9 \\ & 1.9 \\ & 3.6 \end{aligned}$ | V <br> V <br> V <br> mA <br> mA <br> mA |
| TOTAL POWER CONSUMPTION <br> DC Input ( 125 MSPS, Four Channels onto Two Lanes) <br> Sine Wave Input (125 MSPS, Four Channels onto Two Lanes) <br> Power-Down Mode <br> Standby Mode ${ }^{3}$ | $\begin{aligned} & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \\ & 25^{\circ} \mathrm{C} \end{aligned}$ |  | $\begin{aligned} & 688 \\ & 771 \\ & 14 \\ & 520 \end{aligned}$ |  | mW <br> mW <br> mW <br> mW |

[^1]
## Data Sheet

## AC SPECIFICATIONS, $\mathbf{V}_{\text {REF }}=1.4 \mathbf{V}$

AVDD $=1.8 \mathrm{~V}, \mathrm{DRVDD}=1.8 \mathrm{~V}, 2.8 \mathrm{~V}$ p-p full-scale differential input, 1.4 V reference, $\mathrm{A}_{\mathrm{IN}}=-1.0 \mathrm{dBFS}, 125 \mathrm{MSPS}$, unless otherwise noted.
Table 3.

| Parameter ${ }^{1}$ | Temperature | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SIGNAL-TO-NOISE RATIO (SNR) |  |  |  |  |  |
| $\mathrm{fiN}_{\mathrm{I}}=9.7 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 80.1 |  | dBFS |
| $\mathrm{fiN}_{\mathrm{N}}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 79.9 |  | dBFS |
| $\mathrm{fiN}_{\text {I }}=64 \mathrm{MHz}$ | Full | 75.7 | 78.1 |  | dBFS |
| $\mathrm{fiN}_{\text {I }}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 75 |  | dBFS |
| $\mathrm{fix}^{\text {a }}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 72.7 |  | dBFS |
| $\mathrm{fin}_{\text {i }}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 69.7 |  | dBFS |
| SIGNAL-TO-NOISE-AND-DISTORTION (SINAD) RATIO |  |  |  |  |  |
| $\mathrm{fiN}_{\text {I }}=9.7 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 79.6 |  | dBFS |
| $\mathrm{fiN}_{\mathrm{N}}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 78.4 |  | dBFS |
| $\mathrm{fiN}_{\text {I }}=64 \mathrm{MHz}$ | Full | 74.8 | 77.3 |  | dBFS |
| $\mathrm{fiN}_{\text {I }}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 74.4 |  | dBFS |
| $\mathrm{fiN}^{\text {( }}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 71 |  | dBFS |
| $\mathrm{fiN}_{\text {I }}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 68.6 |  | dBFS |
| EFFECTIVE NUMBER OF BITS (ENOB) |  |  |  |  |  |
| $\mathrm{fin}^{\text {a }}=9.7 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 12.9 |  | Bits |
| $\mathrm{fiN}_{\mathrm{N}}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 12.7 |  | Bits |
| $\mathrm{fiN}_{\mathrm{iN}}=64 \mathrm{MHz}$ | Full | 12.1 | 12.5 |  | Bits |
| $\mathrm{fiN}^{\text {( }}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 12.1 |  | Bits |
| $\mathrm{fiN}_{\text {I }}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 11.5 |  | Bits |
| $\mathrm{fiN}_{\text {I }}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 11.1 |  | Bits |
| SPURIOUS-FREE DYNAMIC RANGE (SFDR) |  |  |  |  |  |
| $\mathrm{fiN}_{\text {I }}=9.7 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 89 |  | dBc |
| $\mathrm{fiN}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 87 |  | dBc |
| $\mathrm{fiN}_{\text {in }}=64 \mathrm{MHz}$ | Full | 78 | 86 |  | dBc |
| $\mathrm{fix}^{\text {( }}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 84 |  | dBc |
| $\mathrm{fin}^{\text {a }}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 76 |  | dBC |
| $\mathrm{fin}^{\text {a }}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 75 |  | dBc |
| WORST HARMONIC (SECOND OR THIRD) |  |  |  |  |  |
| $\mathrm{fiN}_{\text {I }}=9.7 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -89 |  | dBc |
| $\mathrm{fiN}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -87 |  | dBc |
| $\mathrm{fiN}_{\mathrm{iN}}=64 \mathrm{MHz}$ | Full |  | -86 | -78 | dBc |
| $\mathrm{fiN}_{\text {I }}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -84 |  | dBc |
| $\mathrm{fiN}_{\text {I }}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -76 |  | dBc |
| $\mathrm{fin}^{\text {a }}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -75 |  | dBc |
| WORST OTHER SPUR OR HARMONIC (EXCLUDING SECOND OR THIRD) |  |  |  |  |  |
| $\mathrm{fiN}_{\text {I }}=9.7 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -96 |  | dBc |
| $\mathrm{fiN}_{\mathrm{N}}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -92 |  | dBc |
| $\mathrm{fiN}_{\text {i }}=64 \mathrm{MHz}$ | Full |  | -90 | -87 | dBC |
| $\mathrm{fin}^{\text {i }}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -89 |  | dBC |
| $\mathrm{fiN}_{\text {I }}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -93 |  | dBC |
| $\mathrm{fiN}_{\text {I }}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -90 |  | dBc |

## AD9656

| Parameter ${ }^{1}$ | Temperature | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| TWO-TONE INTERMODULATION DISTORTION (IMD)—INPUT AMPLITUDE $=-7.0 \mathrm{dBFS}$ $\mathrm{f}_{\mathrm{N} 1}=70.5 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN} 2}=72.5 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -84 |  | dBc |
| CROSSTALK ${ }^{2}$ | $25^{\circ} \mathrm{C}$ |  | -93 |  | dB |
| CROSSTALK (OVERRANGE CONDITION) ${ }^{3}$ | $25^{\circ} \mathrm{C}$ |  | -89 |  | dB |
| ANALOG INPUT BANDWIDTH, FULL POWER | $25^{\circ} \mathrm{C}$ |  | 650 |  | MHz |

${ }^{1}$ See the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation, for definitions and for details on how these tests were completed.
${ }^{2}$ Crosstalk is measured at 70 MHz with -1.0 dBFS analog input on one channel and no input on the adjacent channel.
${ }^{3}$ Overrange condition is defined as the input being 3 dB above full scale.

## AC SPECIFICATIONS, $\mathbf{V}_{\text {REF }}=1.0 \mathbf{V}$

$\mathrm{AVDD}=1.8 \mathrm{~V}, \mathrm{DRVDD}=1.8 \mathrm{~V}, 2.0 \mathrm{~V}$ p-p full-scale differential input, 1.0 V reference, $\mathrm{A}_{\mathrm{N}}=-1.0 \mathrm{dBFS}, 125 \mathrm{MSPS}$, unless otherwise noted.
Table 4.

| Parameter ${ }^{1}$ | Temperature | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SIGNAL-TO-NOISE RATIO (SNR) |  |  |  |  |  |
| $\mathrm{fin}^{\text {f }}$ 9.7 MHz | $25^{\circ} \mathrm{C}$ |  | 78 |  | dBFS |
| $\mathrm{fiN}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 77.9 |  | dBFS |
| $\mathrm{fiN}_{\text {I }}=64 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 76.8 |  | dBFS |
| $\mathrm{fiN}_{\text {I }}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 74.3 |  | dBFS |
| $\mathrm{fiN}_{\mathrm{N}}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 72.1 |  | dBFS |
| $\mathrm{fiN}_{\text {I }}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 69.3 |  | dBFS |
| SIGNAL-TO-NOISE-AND-DISTORTION (SINAD) RATIO |  |  |  |  |  |
| $\mathrm{fin}_{\text {IN }}=9.7 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 78 |  | dBFS |
| $\mathrm{f}_{\mathrm{N}}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 77.7 |  | dBFS |
| $\mathrm{fin}=64 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 76.1 |  | dBFS |
| $\mathrm{fiN}^{\mathrm{N}}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 74 |  | dBFS |
| $\mathrm{fix}^{\text {i }}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 71.1 |  | dBFS |
| $\mathrm{fin}^{\text {a }}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 68.6 |  | dBFS |
| EFFECTIVE NUMBER OF BITS (ENOB) |  |  |  |  |  |
| $\mathrm{fiN}_{\text {IN }}=9.7 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 12.7 |  | Bits |
| $\mathrm{fiN}_{\mathrm{N}}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 12.6 |  | Bits |
| $\mathrm{fin}^{\text {a }}=64 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 12.3 |  | Bits |
| $\mathrm{fiN}^{\text {i }}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 12.0 |  | Bits |
| $\mathrm{fiN}^{\text {( }}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 11.5 |  | Bits |
| $\mathrm{fiN}_{\text {I }}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 11.1 |  | Bits |
| SPURIOUS-FREE DYNAMIC RANGE (SFDR) |  |  |  |  |  |
| $\mathrm{fiN}^{\text {a }}=9.7 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 99 |  | dBC |
| $\mathrm{f}_{\mathrm{N}}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 92 |  | dBC |
| $\mathrm{fiN}_{\mathrm{iN}}=64 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 89 |  | dBc |
| $\mathrm{fin}^{\text {i }}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 87 |  | dBc |
| $\mathrm{fin}^{\text {¢ }}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 78 |  | dBc |
| $\mathrm{fiN}_{\text {I }}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | 78 |  | dBc |
| WORST HARMONIC (SECOND OR THIRD) |  |  |  |  |  |
| $\mathrm{fiN}_{\text {I }}=9.7 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -99 |  | dBc |
| $\mathrm{fiN}_{\mathrm{N}}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -92 |  | dBC |
| $\mathrm{fiN}_{\mathrm{iN}}=64 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -89 |  | dBc |
| $\mathrm{fiN}^{\text {}}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -87 |  | dBc |
| $\mathrm{fiN}^{\mathrm{N}}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -78 |  | dBc |
| $\mathrm{fiN}^{\text {a }}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -78 |  | dBc |


| Parameter ${ }^{1}$ | Temperature | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| WORST OTHER SPUR OR HARMONIC (EXCLUDING SECOND OR THIRD) |  |  |  |  |  |
| $\mathrm{fiN}_{\text {I }}=9.7 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -95 |  | dBc |
| $\mathrm{fiN}_{\text {N }}=16 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -95 |  | dBc |
| $\mathrm{fiN}_{\mathrm{iN}}=64 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -94 |  | dBc |
| $\mathrm{fiN}_{\text {I }}=128 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -89 |  | dBc |
| $\mathrm{fiN}_{\text {I }}=201 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -91 |  | dBc |
| $\mathrm{fin}^{\mathrm{N}}=301 \mathrm{MHz}$ | $25^{\circ} \mathrm{C}$ |  | -89 |  | dBc |
| $\begin{aligned} & \text { TWO-TONE INTERMODULATION DISTORTION (IMD)—INPUT AMPLITUDE }=-7.0 \mathrm{dBFS} \\ & \mathrm{fiN} 1=70.5 \mathrm{MHz}, \mathrm{f}_{\mathrm{I} 2}=72.5 \mathrm{MHz} \end{aligned}$ | $25^{\circ} \mathrm{C}$ |  | -89 |  | dBc |
| CROSSTALK ${ }^{2}$ | $25^{\circ} \mathrm{C}$ |  | -94 |  | dB |
| CROSSTALK (OVERRANGE CONDITION) ${ }^{3}$ | $25^{\circ} \mathrm{C}$ |  | -89 |  | dB |
| ANALOG INPUT BANDWIDTH, FULL POWER | $25^{\circ} \mathrm{C}$ |  | 650 |  | MHz |

${ }^{1}$ See the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation, for definitions and for details on how these tests were completed.
${ }^{2}$ Crosstalk is measured at 70 MHz with -1.0 dBFS analog input on one channel and no input on the adjacent channel.
${ }^{3}$ Overrange condition is defined as the input being 3 dB above full-scale.

## DIGITAL SPECIFICATIONS

$\mathrm{AVDD}=1.8 \mathrm{~V}, \mathrm{DRVDD}=1.8 \mathrm{~V}, \mathrm{SVDD}=1.8 \mathrm{~V}, 2.8 \mathrm{~V}$ p-p differential input, 1.4 V reference, $\mathrm{A}_{\text {IN }}=-1.0 \mathrm{dBFS}$, unless otherwise noted.
Table 5.

| Parameter ${ }^{1}$ | Temperature | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CLOCK INPUTS (CLK $\pm$ ) |  | CMOS/LVDS/LVPECL |  |  |  |
| Logic Compliance |  |  |  |  |  |
| Differential Input Voltage Range ${ }^{2}$ | Full | 0.2 |  | 3.6 | $V \mathrm{p}$-p |
| Input Voltage Range | Full | AGND - 0.2 |  | AVDD + 0.2 | V |
| Input Common-Mode Voltage | Full |  | 0.9 |  | V |
| Input Resistance (Differential) | $25^{\circ} \mathrm{C}$ |  | 15 |  | $\mathrm{k} \Omega$ |
| Input Capacitance | $25^{\circ} \mathrm{C}$ |  | 4 |  | pF |
| SYNCINB INPUT (SYNCINB $\pm$ ) |  |  |  |  |  |
| Logic Compliance |  | LVDS |  |  |  |
| Internal Common-Mode Bias | Full |  | 0.9 |  | V |
| Differential Input Voltage Range | Full | 0.3 |  | 3.6 | Vp-p |
| Input Voltage Range | Full | DGND |  | DVDD | $v$ |
| Input Common-Mode Voltage Range | Full | 0.9 |  | 1.4 | V |
| High Level Input Current | Full | -5 |  | +5 | $\mu \mathrm{A}$ |
| Low Level Input Current | Full | -5 |  | +5 | $\mu \mathrm{A}$ |
| Input Capacitance | Full |  | 1 |  | pF |
| Input Resistance | Full | 12 | 16 | 20 | $\mathrm{k} \Omega$ |
| SYSREF INPUT (SYSREF $\pm$ ) |  | LVDS |  |  |  |
| Logic Compliance |  |  |  |  |  |
| Internal Common-Mode Bias | Full | 0.9 |  |  | V |
| Differential Input Voltage Range | Full | 0.3 |  | 3.6 | Vp-p |
| Input Voltage Range | Full | AGND |  | AVDD | V |
| Input Common-Mode Voltage Range | Full | 0.9 |  | 1.4 | V |
| High Level Input Current | Full | -5 |  | +5 | $\mu \mathrm{A}$ |
| Low Level Input Current | Full | -5 |  | +5 | $\mu \mathrm{A}$ |
| Input Capacitance | Full |  | 4 |  | pF |
| Input Resistance | Full | 8 | 10 | 12 | $\mathrm{k} \Omega$ |
| LOGIC INPUT (SYNC) |  |  |  |  |  |
| Logic 1 Voltage Range | Full | 1.2 |  | AVDD + 0.2 | V |
| Logic 0 Voltage Range | Full | 0 |  | 0.8 | V |
| Input Resistance | $25^{\circ} \mathrm{C}$ |  | 30 |  | $\mathrm{k} \Omega$ |
| Input Capacitance | $25^{\circ} \mathrm{C}$ |  | 2 |  | pF |

## AD9656

| Parameter ${ }^{1}$ | Temperature | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| LOGIC INPUTS (CSB, PDWN, SCLK) <br> Logic 1 Voltage Range Logic 0 Voltage Range Input Resistance Input Capacitance | Full <br> Full <br> $25^{\circ} \mathrm{C}$ <br> $25^{\circ} \mathrm{C}$ | $\begin{aligned} & 1.2 \\ & 0 \end{aligned}$ | $\begin{aligned} & 26 \\ & 2 \end{aligned}$ | $\begin{aligned} & \text { SVDD }+0.2 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{k} \Omega \\ & \mathrm{pF} \end{aligned}$ |
| LOGIC INPUT (SDIO) Logic 1 Voltage Range Logic 0 Voltage Range Input Resistance Input Capacitance | Full <br> Full <br> $25^{\circ} \mathrm{C}$ <br> $25^{\circ} \mathrm{C}$ | $\begin{aligned} & 1.2 \\ & 0 \end{aligned}$ | $\begin{aligned} & 26 \\ & 5 \end{aligned}$ | $\begin{aligned} & \text { SVDD }+0.2 \\ & 0.8 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{k} \Omega \\ & \mathrm{pF} \end{aligned}$ |
| ```LOGIC OUTPUT (SDIO)}\mp@subsup{}{}{3 Logic 1 Voltage (lон = 800 \muA) Logic 0 Voltage (loL=50 \muA)``` | Full Full |  | 1.79 | 0.05 | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| DIGITAL OUTPUTS (SERDOUTx $\pm$ ) <br> Logic Compliance <br> Differential Output Voltage (Vod) <br> Output Offset Voltage (Vos) | Full <br> Full <br> Full | $\begin{aligned} & 400 \\ & 0.75 \end{aligned}$ | $\begin{aligned} & \text { CML } \\ & 600 \\ & \text { DRVDD/2 } \end{aligned}$ | $\begin{aligned} & 750 \\ & 1.05 \end{aligned}$ | $\begin{aligned} & \mathrm{mV} \\ & \mathrm{~V} \end{aligned}$ |

${ }^{1}$ See the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation, for definitions and for details on how these tests were completed.
${ }^{2}$ Specified for LVDS and LVPECL only.
${ }^{3}$ Specified for the SDIO pins on 13 individual AD9656 devices sharing the same connection.

## SWITCHING SPECIFICATIONS

$\mathrm{AVDD}=1.8 \mathrm{~V}, \mathrm{DRVDD}=1.8 \mathrm{~V}, 2.8 \mathrm{~V}$ p-p differential input, 1.4 V reference, $\mathrm{A}_{\mathrm{IN}}=-1.0 \mathrm{dBFS}$, unless otherwise noted.
Table 6.

| Parameter ${ }^{1,2}$ | Temperature | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CLOCK ${ }^{3}$ |  |  |  |  |  |
| Input Clock Rate | Full | 40 |  | 1000 | MHz |
| Conversion Rate ${ }^{4}$ | Full | 40 |  | 125 | MSPS |
| Clock Pulse Width High ( $\mathrm{teH}^{\text {) }}$ | Full |  | 4.00 |  | ns |
| Clock Pulse Width Low (tel) | Full |  | 4.00 |  | ns |
| SYNC Setup Time to Clock | Full |  |  | 1.4 | ns |
| SYNC Hold Time to Clock | Full |  |  | -0.4 | ns |
| SYSREF Setup Time to Clock ( $\left.\mathrm{t}_{\text {REFS }}\right)^{5}$ | Full |  | 370 | 600 | ps |
| SYSREF Hold Time to Clock (trefy) ${ }^{5}$ | Full |  | -92 | 0 | ps |
| DATA OUTPUT PARAMETERS |  | $\mathrm{L} /\left(20 \times \mathrm{M} \times \mathrm{f}_{\mathrm{s}}\right)$ |  |  |  |
| Data Output Period or Unit Interval (UI) | Full |  |  |  | Seconds |
| Data Output Duty Cycle | $25^{\circ} \mathrm{C}$ | 50 |  |  | \% |
| Data Valid Time | $25^{\circ} \mathrm{C}$ | 0.81 |  |  | UI |
| PLL Lock Time (tlock) ${ }^{6}$ | $25^{\circ} \mathrm{C}$ | 86 |  |  | $\mu \mathrm{s}$ |
| Wake-Up Time |  | 250 |  |  |  |
| Standby | $25^{\circ} \mathrm{C}$ |  |  |  | ns |
| ADC (Power-Down) ${ }^{7}$ | $25^{\circ} \mathrm{C}$ | 375 |  |  | $\mu \mathrm{s}$ |
| Output (Power-Down) ${ }^{8}$ | $25^{\circ} \mathrm{C}$ | 86 |  |  | $\mu \mathrm{s}$ |
| SYNCINB Falling Edge to First K. 28 Characters | Full | 4 |  |  | Multiframes |
| CGS Phase K. 28 Characters Duration | Full | 1 |  | 6 | Multiframe |
| Subclass 1: SYSREF Rising Edge to First Valid K. 28 Characters ${ }^{9}$ | Full | 5 |  |  | Multiframe |
| Pipeline Delay |  |  |  |  |  |
| JESD204B M4, L1 Mode (Latency) | Full |  | 23 |  | Cycles ${ }^{10}$ |
| JESD204B M4, L2 Mode (Latency) | Full |  | 29 |  | Cycles ${ }^{10}$ |
| JESD204B M4, L4 Mode (Latency) | Full |  | 44 |  | Cycles ${ }^{10}$ |
| Data Rate per Lane | Full |  |  | 8.0 | Gbps |

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| Parameter ${ }^{1,2}$ | Temperature | Min | Typ $\quad$ Max |
| :--- | :--- | :--- | :--- |
| Unit |  |  |  |
| At 6.4 Gbps |  |  |  |
| Random Jitter (RJ) | $25^{\circ} \mathrm{C}$ | 8 | ps |
| At 6.4 Gbps |  |  |  |
| Output Rise Time/Fall Time | $25^{\circ} \mathrm{C}$ | 1.25 | ps rms |
| Differential Termination Resistance | $25^{\circ} \mathrm{C}$ | 50 | ps |
| APERTURE | $25^{\circ} \mathrm{C}$ | 100 | $\Omega$ |
| Aperture Delay (t $\mathrm{t}_{\mathrm{A}}$ ) |  |  |  |
| Aperture Uncertainty (Jitter, t ) | $25^{\circ} \mathrm{C}$ | 1 | ns |
| Out of Range Recovery Time | $25^{\circ} \mathrm{C}$ | 135 | fs rms |

${ }^{1}$ See the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation, for definitions and for details on how these tests were completed.
${ }^{2}$ Measured on standard FR-4 material.
${ }^{3}$ The clock divider can be adjusted via the SPI. The conversion rate is the clock rate after the divider.
${ }^{4}$ Maximum conversion rate is with the AD9656 not limited by the maximum allowable output data rate. See the Digital Outputs and Timing section for information on conditions when the conversion rate is limited by the maximum allowable output data rate.
${ }^{5}$ Refer to Figure 3 for timing diagram.
${ }^{6}$ Typical PLL lock time at 125 MSPS ( $24 \mu \mathrm{~s}+7680$ sample clock periods)
${ }^{7}$ Time required for the ADC to return to normal operation from power-down mode.
${ }^{8}$ Time required for the JESD204B output to return to normal operation from power-down mode at 125 MSPS (PLL lock time +13 sample clock periods)
${ }^{9}$ Delay required for SYNCINB rising edge/Rx CGS start. See Figure 66.
${ }^{10} \mathrm{ADC}$ conversion rate cycles.

## TIMING SPECIFICATIONS

Table 7.

| Parameter | Description | Limit | Unit |
| :---: | :---: | :---: | :---: |
| SPITIMING REQUIREMENTS | See Figure 74 |  |  |
| tDs | Setup time between the data and the rising edge of SCLK | 2 | $n \mathrm{nmin}$ |
| $\mathrm{t}_{\mathrm{DH}}$ | Hold time between the data and the rising edge of SCLK | 2 | $n \mathrm{nmin}$ |
| tcık | Period of the SCLK | 40 | ns min |
| ts | Setup time between CSB and SCLK | 2 | ns min |
| $\mathrm{tH}_{\mathrm{H}}$ | Hold time between CSB and SCLK | 2 | ns min |
| thigh | SCLK pulse width high | 10 | ns min |
| tow | SCLK pulse width low | 10 | $n \mathrm{nmin}$ |
| ten_solo | Time required for the SDIO pin to switch from an input to an output relative to the SCLK falling edge (not shown in Figure 74) | 10 | ns min |
| $\mathrm{t}_{\text {IIS_SDIO }}$ | Time required for the SDIO pin to switch from an output to an input relative to the SCLK rising edge (not shown in Figure 74) | 10 | $n \mathrm{nmin}$ |

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## Timing Diagrams

Refer to the Memory Map Register Table section for SPI register settings.


Figure 2. Data Output Timing, $M=4, L=1$


Figure 3. SYSREF $\pm$ Setup and Hold Timing (Clock Divider = 1)

## ABSOLUTE MAXIMUM RATINGS

Table 8.

| Parameter | Rating |
| :--- | :--- |
| Electrical |  |
| AVDD to AGND | -0.3 V to +2.0 V |
| DRVDD to AGND | -0.3 V to +2.0 V |
| DVDD to DVSS | -0.3 V to +2.0 V |
| SVDD to AGND | -0.3 V to +3.9 V |
| Digital Outputs to AGND | -0.3 V to +2.0 V |
| CLK + , CLK - to AGND | -0.3 V to +2.0 V |
| VINx+, VINx- to AGND | -0.3 V to +2.0 V |
| SYSREF $\pm$ to AGND | -0.3 V to +2.0 V |
| SYNCINB $\pm$ to AGND | -0.3 V to +2.0 V |
| SCLK, SDIO, CSB, PDWN to AGND | -0.3 V to +3.9 V |
| SYNC to AGND | -0.3 V to +2.0 V |
| RBIAS to AGND | -0.3 V to +2.0 V |
| VCM, VREF, SENSE to AGND | -0.3 V to +2.0 V |
| Environmental |  |
| Operating Temperature Range (Ambient) | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature | $150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10 sec) | $300^{\circ} \mathrm{C}$ |
| Storage Temperature Range (Ambient) | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

$\theta_{J A}$ is for a 4-layer printed circuit board (PCB) with solid ground plane (simulated). The exposed pad is soldered to the PCB ground.

Table 9. Thermal Resistance

| Package <br> Type | Air Flow <br> Velocity <br> $(\mathbf{m} / \mathbf{s e c})$ | $\boldsymbol{\theta}_{\mathrm{JA}}$ <br> $\left({ }^{\circ} \mathbf{C} / \mathbf{W}\right)$ | $\boldsymbol{\theta}_{\mathbf{J B}}$ <br> $\left({ }^{\circ} \mathbf{C} / \mathbf{W}\right)^{1}$ | $\boldsymbol{\theta}_{\mathrm{JC}}$ Top <br> $\left({ }^{\circ} \mathbf{C} / \mathbf{W}\right)^{\mathbf{1}}$ | $\boldsymbol{\theta}_{\mathbf{\prime C}}$ Bottom <br> $\left({ }^{\circ} \mathbf{C} / \mathbf{W}\right)^{\mathbf{1}}$ |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $56-$ Lead | 0 | 22.4 | 7.7 | 7.42 | 2.29 |
| LFCSP, | 1 | 19.0 | $\mathrm{~N} / \mathrm{A}$ | $\mathrm{N} / \mathrm{A}$ | $\mathrm{N} / \mathrm{A}$ |
| $8 \mathrm{~mm} \times$ | 2.5 | 17.6 | $\mathrm{~N} / \mathrm{A}$ | $\mathrm{N} / \mathrm{A}$ | $\mathrm{N} / \mathrm{A}$ |
| 8 mm |  |  |  |  |  |

${ }^{1}$ N/A means not applicable.

## ESD CAUTION

|  | ESD (electrostatic discharge) sensitive device. <br> Charged devices and circuit boards can discharge <br> without detection. Although this product features <br> patented or proprietary protection circuitry, damage <br> may occur on devices subjected to high energy ESD. <br> Therefore, proper ESD precautions should be taken to <br> avoid performance degradation or loss of functionality. |
| :--- | :--- |

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Table 10. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
| :--- | :--- | :--- |
| 0 | AGND, | Analog Ground, Exposed Pad. The exposed thermal pad on the bottom of the package provides the |
| $1,4,5,8,11,39,42$, | Exposed Pad | analog ground for the device. This exposed pad must be connected to ground for proper operation. <br> $43,46,52,53,56$ <br> 2 |
| 1.8 V Analog Supply Pins. |  |  |
| 3 | VIND+ | ADC D Analog Input True. |
| 6,7 | VIND- | ADC D Analog Input Complement. |
| 9 | CLK-, CLK+ | Differential Encode Clock. PECL, LVDS, or 1.8 V CMOS inputs. |
| 10 | SYSREF+ | Active High JESD204B LVDS SYSREF Input True. |
| 12,32 | SYSREF- | Active High JESD204B LVDS SYSREF Input Complement. |
| 13,31 | DVDD | Digital Supply. |
| $14,15,29,30$ | DVSS | Digital Ground. |
| 16 | SIC | Not Internally Connected. Can be connected to ground if desired. |
| 17 | SYNCINB+ | Active Low JESD204B LVDS SYNC Input True. |
| $18,23,28$ | SYNCINB- | Active Low JESD204B LVDS SYNC Input Complement. |
| 19 | DRVDD | Digital Output Driver Supply. |
| 20 | SERDOUT3- | Lane 3 Digital Output Complement. |
| 21 | SERDOUT3+ | Lane 3 Digital Output True. |
| 22 | SERDOUT2+ | Lane 2 Digital Output True. |
| 24 | SERDOUT2- | Lane 2 Digital Output Complement. |
| 25 | SERDOUT1- | Lane 1 Digital Output Complement. |
| 26 | SERDOUT1+ | Lane 1 Digital Output True. |
| 27 | SERDOUT0+ | Lane 0 Digital Output True. |
| 33 | SERDOUT0- | Lane 0 Digital Output Complement. |

## AD9656

| Pin No. | Mnemonic | Description |
| :--- | :--- | :--- |
| 34 | DNC | Do Not Connect. Do not connect to this pin. |
| 35 | SCLK | SPI Clock Input. |
| 36 | SDIO | SPI Data Input and Output, Bidirectional. |
| 37 | CSB | SPI Chip Select Bar. Active low enable; $30 \mathrm{k} \Omega$ internal pull-up resistor. |
| 38 | PDWN | Digital Input. This pin has a $30 \mathrm{k} \Omega$ internal pull-down resistor. PDWN high = power-down device and |
|  |  | PDWN low = run device (normal operation). |
| 40 | VINA- | ADC A Analog Input Complement. |
| 41 | VINA+ | ADC A Analog Input True. |
| 44 | VINB+ | ADC B Analog Input True. |
| 45 | VINB- | ADC B Analog Input Complement. |
| 47 | RBIAS | Sets Analog Current Bias. This pin connects a $10 \mathrm{k} \Omega$ (1\% tolerance) resistor to ground. |
| 48 | SENSE | Reference Mode Selection. |
| 49 | VREF | Voltage Reference Input and Output. |
| 50 | VCM | Analog Input Common-Mode Voltage. |
| 51 | SYNC | Digital Input. Synchronous input to clock divider. |
| 54 | VINC- | ADC C Analog Input Complement. |
| 55 | VINC+ | ADC C Analog Input True. |

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 5. Single-Tone 32k FFT with $f_{i N}=9.7 \mathrm{MHz}$,
$f_{S A M P L E}=125 \mathrm{MSPS}, V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 6. Single-Tone 32k FFT with $f_{I N}=16.3 \mathrm{MHz}$,
$f_{\text {SAMPLE }}=125$ MSPS, $V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 7. Single-Tone 32k FFT with $\mathrm{f}_{\mathrm{N}}=64 \mathrm{MHz}$,
$f_{\text {SAMPLE }}=125$ MSPS, $V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 8. Single-Tone 32k FFT with $f_{I N}=128.1 \mathrm{MHz}$,
$f_{S A M P L E}=125$ MSPS, $V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 9. Single-Tone 32k FFT with $f_{I N}=201$ MHz, $f_{\text {SAMPLE }}=125$ MSPS, $V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 10. Single-Tone 32k FFT with $f_{i N}=301 \mathrm{MHz}$,
$f_{\text {SAMPLE }}=125$ MSPS, $V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 11. SNR/SFDR vs. Input Amplitude ( $A_{I N}$ ), $f_{I N}=9.7 \mathrm{MHz}$, $f_{S A M P L E}=125 \mathrm{MSPS}, V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 12. Two-Tone 32 kFFT with $f_{\mathrm{IN}_{1}}=70.5 \mathrm{MHz}$ and $f_{\mathrm{IN}_{2}}=72.5 \mathrm{MHz}$, $f_{S A M P L E}=125 \mathrm{MSPS}, V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 13. Two-Tone SFDR/IMD3 vs. Input Amplitude ( $A_{I N}$ ) with $f_{I N 1}=70.5 \mathrm{MHz}$ and $f_{I N 2}=72.5 \mathrm{MHz}, f_{\text {SAMPLE }}=125 \mathrm{MSPS}, V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 14. SNR/SFDR vs. Input Frequency $\left(f_{I N}\right), f_{\text {SAMPLE }}=125$ MSPS, $V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 15. SNR/SFDR vs. Temperature, $f_{i N}=9.7 \mathrm{MHz}$, $f_{\text {SAMPLE }}=125 \mathrm{MSPS}, V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 16. Integral Nonlinearity (INL), $f_{I N}=9.7 \mathrm{MHz}, f_{\text {SAMPLE }}=125 \mathrm{MSPS}$,
$V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 17. Differential Nonlinearity (DNL), $f_{I N}=9.7 \mathrm{MHz}, f_{\text {SAMPLE }}=125 \mathrm{MSPS}$, $V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 18. Input Referred Noise Histogram, $f_{\text {SAMPLE }}=125$ MSPS, $V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 19. SNR/SFDR vs. Sample Rate, $f_{I N}=9.7 \mathrm{MHz}, V_{\text {REF }}=1.4 \mathrm{~V}$


Figure 20. SNR/SFDR vs. Sample Rate, $f_{i N}=64 \mathrm{MHz}, V_{\text {REF }}=1.4 \mathrm{~V}$

## $V_{\text {REF }}=1.0 \mathrm{~V}$



Figure 21. Single-Tone 32k FFT with $f_{I N}=9.7 \mathrm{MHz}$,
$f_{\text {SAMPLE }}=125 \mathrm{MSPS}, V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 22. Single-Tone 32k FFT with $f_{i N}=16.3 \mathrm{MHz}$, $f_{S A M P L E}=125 \mathrm{MSPS}, V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 23. Single-Tone 32 k FFT with $f_{I N}=64 \mathrm{MHz}, f_{\text {SAMPLE }}=125 \mathrm{MSPS}$,
$V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 24. Single-Tone 32k FFT with $f_{i N}=128.1 \mathrm{MHz}$, $f_{\text {SAMPLE }}=125 \mathrm{MSPS}, V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 25. Single-Tone 32k FFT with $f_{I N}=201$ MHz, $f_{\text {SAMPLE }}=125 \mathrm{MSPS}, V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 26. Single-Tone 32k FFT with $f_{I N}=301 \mathrm{MHz}, f_{S A M P L E}=125 \mathrm{MSPS}$,
$V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 27. SNR/SFDR vs. Input Amplitude $\left(A_{I N}\right), f_{i N}=9.7 \mathrm{MHz}$, $f_{\text {SAMPLE }}=125$ MSPS, $V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 28. Two-Tone 32k FFT with $f_{I N 1}=70.5 \mathrm{MHz}$ and $f_{\mathrm{IN}_{2}}=72.5 \mathrm{MHz}$, $f_{\text {SAMPLE }}=125 \mathrm{MSPS}, V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 29. Two-Tone SFDR/IMD3 vs. Input Amplitude ( $A_{I N}$ ) with $f_{I N 1}=70.5 \mathrm{MHz}$ and $f_{I N 2}=72.5 \mathrm{MHz}, f_{\text {SAMPLE }}=125 \mathrm{MSPS}, V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 30. SNR/SFDR vs. Input Frequency $\left(f_{I N}\right), f_{S A M P L E}=125 \mathrm{MSPS}, V_{R E F}=1.0 \mathrm{~V}$


Figure 31. $\mathrm{SNR} / \mathrm{SFDR}$ vs. Temperature, $\mathrm{fiN}_{\mathrm{N}}=9.7 \mathrm{MHz}$ $f_{S A M P L E}=125 \mathrm{MSPS}, V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 32. Integral Nonlinearity (INL), $f_{I N}=9.7 \mathrm{MHz}, f_{\text {SAMPLE }}=125 \mathrm{MSPS}$, $V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 33. Differential Nonlinearity (DNL), $f_{I N}=9.7 \mathrm{MHz}, f_{\text {SAMPLE }}=125 \mathrm{MSPS}$, $V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 34. Input Referred Noise Histogram, $f_{\text {SAMPLE }}=125 \mathrm{MSPS}, V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 35. SNR/SFDR vs. Sample Rate, $f_{I N}=9.7 \mathrm{MHz}, V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 36. SNR/SFDR vs. Sample Rate, $f_{I N}=64 \mathrm{MHz}, V_{\text {REF }}=1.0 \mathrm{~V}$

## EQUIVALENT CIRCUITS



Figure 37. Equivalent Analog Input Circuit


Figure 38. Equivalent Clock Input Circuit


Figure 39. Equivalent SDIO Input Circuit


Figure 40. Equivalent SERDOUTx $\pm$ Circuit


Figure 41. Equivalent SYNC Input Circuit


Figure 42. Equivalent SCLK and PDWN Input Circuit


Figure 43. Equivalent RBIAS and VCM Circuit


Figure 44. Equivalent CSB Input Circuit


Figure 45. Equivalent VREF Circuit

## THEORY OF OPERATION

The AD9656 is a multistage, pipelined ADC. Each stage provides sufficient overlap to correct for flash errors in the preceding stage. The quantized outputs from each stage are combined into a final 16-bit result in the digital correction logic. The serializer transmits this converted data in a 16 -bit output. The pipelined architecture permits the first stage to operate with a new input sample while the remaining stages operate with the preceding samples. Sampling occurs on the rising edge of the clock.
Each stage of the pipeline, excluding the last, consists of a low resolution flash ADC connected to a switched-capacitor DAC and an interstage residue amplifier (for example, a multiplying digital-to-analog converter [MDAC]). The residue amplifier magnifies the difference between the reconstructed DAC output and the flash input for the next stage in the pipeline. One bit of redundancy is used in each stage to facilitate digital correction of flash errors. The last stage simply consists of a flash ADC.
The output staging block aligns the data, corrects errors, and passes the data to the output buffers. The data is then serialized and aligned to the frame and data clocks.

## ANALOG INPUT CONSIDERATIONS

The analog input to the AD9656 is a differential switchedcapacitor circuit designed for processing differential input signals. This circuit can support a wide common-mode range while maintaining excellent performance. By using an input common-mode voltage of midsupply, users can minimize signal-dependent errors and achieve optimum performance.


Figure 46. Switched-Capacitor Input Circuit
The clock signal alternately switches the input circuit between sample mode and hold mode (see Figure 46). When the input circuit is switched to sample mode, the signal source must be capable of charging the sample capacitors and settling within one-half of a clock cycle. A small resistor in series with each input can help reduce the peak transient current injected from the output stage of the driving source. In addition, low Q inductors or ferrite beads can be placed on each leg of the input to reduce high differential capacitance at the analog inputs and therefore achieve the maximum bandwidth of the ADC. Such use of low Q inductors
or ferrite beads is required when driving the converter front end at high IF frequencies.
Either a differential capacitor or two single-ended capacitors can be placed on the inputs to provide a matching passive network. This ultimately creates a low-pass filter at the input to limit unwanted broadband noise. See the AN-742 Application Note, the AN-827 Application Note, and the Analog Dialogue article "Transformer-Coupled Front-End for Wideband A/D Converters" for more information. In general, the precise values depend on the application.

## Input Common-Mode Voltage

The analog inputs of the AD9656 are not internally dc-biased. Therefore, in ac-coupled applications, the user must provide this bias externally. Setting the device so that $\mathrm{V}_{\mathrm{CM}}=\mathrm{AVDD} / 2$ is recommended for optimum performance, but the device can function over a wider $\mathrm{V}_{\mathrm{CM}}$ range with reasonable performance, as shown in Figure 47 and Figure 48.


Figure 47. SNR/SFDR vs. Common-Mode Voltage (VCM), $f_{I N}=9.7 \mathrm{MHz}, f_{\text {SAMPLE }}=125 \mathrm{MSPS}, V_{\text {REF }}=1.0 \mathrm{~V}$


Figure 48. SNR/SFDR vs. Common-Mode Voltage (VCM), $f_{I N}=9.7 \mathrm{MHz}, f_{\text {SAMPLE }}=125 \mathrm{MSPS}, V_{\text {REF }}=1.4 \mathrm{~V}$

## AD9656

An on-chip, common-mode voltage reference is included in the design and is available from the VCM pin. Bypass the VCM pin to ground with a $0.1 \mu \mathrm{~F}$ capacitor, as described in the Applications Information section.
Maximum SNR performance is achieved by setting the ADC to the largest span in a differential configuration. In the case of the AD9656, the input span is dependent on the reference voltage (see Table 11).

## Differential Input Configurations

There are several ways to drive the AD9656 either actively or passively. However, optimum performance is achieved by driving the analog inputs differentially. Using a differential double balun configuration to drive the AD9656 provides excellent performance and a flexible interface to the ADC for baseband applications (see Figure 49).

For applications where SNR is a key parameter, differential transformer coupling is the recommended input configuration (see Figure 50) because the noise performance of most amplifiers is not adequate to achieve the true performance of the AD9656.
Regardless of the configuration, the value of the shunt capacitor, C , is dependent on the input frequency and may need to be reduced or removed.

It is not recommended to drive the AD9656 inputs single-ended.


Figure 49. Differential Double Balun Input Configuration for Baseband Applications


Figure 50. Differential Transformer-Coupled Configuration for Baseband Applications
Table 11. Reference Configuration Summary

| Selected Mode | SENSE Voltage (V) | Resulting $\mathrm{V}_{\text {ref }}(\mathrm{V})$ | Resulting Differential Span (V p-p) |
| :---: | :---: | :---: | :---: |
| Fixed Internal Reference | AGND to 0.2V | 1.0 V to 1.4 V internal, SPI selectable with Register 0x18, Bits[7:6] | 2.0 to 2.8 |
| Programmable Internal Reference | Tie SENSE pin to external R divider (see Figure 52) | $\begin{aligned} & 0.5 \times(1+\mathrm{R} 2 / \mathrm{R} 1) \text {, for example: } \mathrm{R} 1=3.2 \mathrm{k} \Omega \text {, } \\ & \mathrm{R} 2=5.8 \mathrm{k} \Omega \text { for } V_{\text {REF }}=1.4 \mathrm{~V} \end{aligned}$ | $2 \times \mathrm{V}_{\text {REF }}$ |
| Fixed External Reference | AVDD | 1.0 V to 1.4 V applied to external VREF pin | 2.0 to 2.8 |

## VOLTAGE REFERENCE

A stable and accurate voltage reference is built into the AD9656. VREF can be configured using the internal 1.0 V reference, using an externally applied 1.0 V to 1.4 V reference voltage, or using an external resistor divider applied to the internal reference to produce a user-selectable reference voltage. The reference modes are described in the Internal Reference Connection section and the External Reference Operation section. Externally bypass the VREF pin to ground with a low equivalent series resistance (ESR), $1.0 \mu \mathrm{~F}$ capacitor in parallel with a low ESR, $0.1 \mu \mathrm{~F}$ ceramic capacitor.

## Internal Reference Connection

A comparator within the AD9656 detects the potential at the SENSE pin and configures the reference for one of three possible modes, which are summarized in Table 11. If SENSE is grounded, the reference amplifier switch is connected to the internal resistor divider (see Figure 51), setting the voltage at the VREF pin, Vref, to 1.0 V . If SENSE is connected to an external resistor divider (see Figure 52), Vref is defined as

$$
V_{R E F}=0.5 \times\left(1+\frac{R 2}{R 1}\right)
$$

where:

$$
7 \mathrm{k} \Omega \leq(R 1+R 2) \leq 10 \mathrm{k} \Omega
$$



Figure 51. 1.0 V Internal Reference Configuration


Figure 52. Programmable Internal Reference Configuration
If the internal reference of the AD9656 drives multiple converters to improve gain matching, the loading of the reference by the other converters must be considered. Figure 53 and Figure 54 show how the internal reference voltage is affected by loading.


Figure 53. $V_{\text {REF }}$ Error (Internal $V_{\text {REF }}=1.0 \mathrm{~V}$ ) vs. Load Current


Figure 54. $V_{\text {REF }}$ Error (Internal $V_{\text {REF }}=1.4$ V) vs. Load Current

## External Reference Operation

The use of an external reference may be necessary to enhance the gain accuracy of the ADC or to improve thermal drift characteristics. Figure 55 and Figure 56 show the typical drift characteristics of the internal reference in 1.0 V mode and 1.4 V mode, respectively.


Figure 55. $V_{\text {REF }}$ Error vs. Temperature, Typical $V_{\text {REF }}=1.0$ V Drift


Figure 56. $V_{\text {REF }}$ Error vs. Temperature, Typical $V_{\text {REF }}=1.4$ V Drift
When the SENSE pin is tied to AVDD, the internal reference is disabled, allowing the use of an external reference. An internal reference buffer loads the external reference with an equivalent $7.5 \mathrm{k} \Omega$ load. The internal buffer generates the positive and negative full-scale references for the ADC core.

It is not recommended to leave the SENSE pin floating.

## CLOCK INPUT CONSIDERATIONS

For optimum performance, clock the AD9656 sample clock inputs, CLK+ and CLK-, with a differential signal. The signal is typically ac-coupled into the CLK + and CLK- pins via a transformer or capacitors. These pins are biased internally and require no external bias.

## Clock Input Options

The AD9656 has a flexible clock input structure. The clock input can be a CMOS, LVDS, LVPECL, or sine wave signal. Regardless of the type of signal used, clock source jitter is of the most concern, as described in the Jitter Considerations section.
Figure 57 and Figure 58 show two preferred methods for clocking the AD9656 (at clock rates up to 1 GHz prior to internal clock divider). A low jitter clock source is converted from a single-ended signal to a differential signal using either a radio frequency (RF) transformer or an RF balun.

The RF balun configuration is recommended for clock frequencies between 125 MHz and 1 GHz , and the RF transformer configuration is recommended for clock frequencies from 40 MHz to 200 MHz . The Schottky diodes, across the transformer/balun secondary winding, limit clock excursions into the AD9656 to approximately 0.8 V p-p differential (see Figure 57 and Figure 58).
This limit helps prevent the large voltage swings of the clock from feeding through to other portions of the AD9656 while preserving the fast rise and fall times of the signal that are critical to achieving low jitter performance. However, the diode capacitance has an effect on frequencies above 500 MHz . Take care in choosing the appropriate signal limiting diode.


Figure 57. Transformer-Coupled Differential Clock (Up to 200 MHz )


Figure 58. Balun-Coupled Differential Clock (Up to 1 GHz)
If a low jitter clock source is not available, another option is to ac-couple a differential PECL signal to the sample clock input pins, as shown in Figure 59. The AD9510/AD9511/AD9512/ AD9513/AD9514/AD9515/AD9516/AD9517 clock drivers offer excellent jitter performance.


Figure 59. Differential PECL Sample Clock (Up to 1 GHz )

Another option is to ac-couple a differential LVDS signal to the sample clock input pins, as shown in Figure 60. The AD9510/ AD9511/AD9512/AD9513/AD9514/AD9515/AD9516/AD9517 clock drivers offer excellent jitter performance.


Figure 60. Differential LVDS Sample Clock (Up to 1 GHz)
In some applications, it is acceptable to drive the sample clock inputs with a single-ended 1.8 V CMOS signal. In such applications, drive the CLK+ pin directly from a CMOS gate, and bypass the CLK- pin to ground with a $0.1 \mu \mathrm{~F}$ capacitor (see Figure 61).


Figure 61. Single-Ended 1.8 V CMOS Input Clock (Up to 200 MHz )

## Input Clock Divider

The AD9656 contains an input clock divider with the ability to divide the input clock by integer values from 1 to 8 .

The AD9656 clock divider can be synchronized using the external SYNC input. Bit 0 and Bit 1 of Register 0x109 allow the clock divider to resynchronize on every SYNC signal or only on the first SYNC signal after the register is written. A valid SYNC causes the clock divider to reset to the initial state. This synchronization feature allows multiple devices to have the clock dividers aligned to guarantee simultaneous input sampling.
Alternatively, SYSREF $\pm$ can reset the clock divider by setting Register 0x109 Bit[7]. In this case SYNC is disabled.

## Clock Duty Cycle

Typical high speed ADCs use both clock edges to generate a variety of internal timing signals and, as a result, can be sensitive to the clock duty cycle. Commonly, a $\pm 5 \%$ tolerance is required on the clock duty cycle to maintain dynamic performance characteristics.

The AD9656 contains a duty cycle stabilizer (DCS) that retimes the nonsampling (falling) edge, providing an internal clock signal with a nominal $50 \%$ duty cycle. This feature minimizes performance degradation in cases where the clock input duty cycle deviates more than the specified $\pm 5 \%$ from the nominal $50 \%$ duty cycle. Enabling the DCS function can significantly improve noise and distortion performance for clock input duty cycles ranging from $30 \%$ to $45 \%$ and from $55 \%$ to $70 \%$.

Jitter in the rising edge of the input is still of concern and is not easily reduced by the internal stabilization circuit. The loop has a time constant associated with it that must be considered in applications in which the clock rate can change dynamically. A wait time of $1.5 \mu$ s to $5 \mu \mathrm{~s}$ is required after a dynamic clock frequency increase or decrease before the DCS loop is relocked to the input signal.

## Jitter Considerations

High speed, high resolution ADCs are sensitive to the quality of the clock input. The degradation in SNR at a given input frequency $\left(f_{A}\right)$ due only to aperture jitter ( $t_{\mathrm{J}}$ ) can be calculated by

$$
\text { SNR Degradation }=20 \log _{10}\left(\frac{1}{2 \pi \times f_{A} \times t_{J}}\right)
$$

In this equation, the rms aperture jitter represents the root sum square of all jitter sources, including the clock input, analog input signal, and ADC aperture jitter specifications. Intermediate frequency (IF) under-sampling applications are particularly sensitive to jitter (see Figure 62).

Treat the clock input as an analog signal in cases where aperture jitter can affect the dynamic range of the AD9656. Separate power supplies for clock drivers from the supplies for the ADC output driver to avoid modulating the clock signal with digital noise. Low jitter, crystal controlled oscillators make the best clock sources. If the clock is generated from another type of source (by gating, dividing, or other methods), retime it by the original clock at the last step.
Refer to the AN-501 Application Note and the AN-756 Application Note for more in depth information about jitter performance as it relates to ADCs.


Figure 62. Ideal SNR vs. Analog Input Frequency and Jitter

## POWER DISSIPATION AND POWER-DOWN MODE

As shown in Figure 63 and Figure 64, the power dissipated by the AD9656 is proportional to the sample rate.

The AD9656 is placed in power-down mode either by the SPI port or by asserting the PDWN pin high. In power-down mode, the ADC typically dissipates 14 mW . During power-down, the output drivers are placed in a high impedance state. When the PDWN pin is asserted low, the AD9656 returns to normal operating mode. Note that PDWN is referenced to SVDD and must not exceed that supply voltage.
Low power dissipation in power-down mode is achieved by shutting down the reference, reference buffer, biasing networks, and clock. Internal capacitors are discharged when entering power-down mode and must then be recharged when returning to normal operation. As a result, wake-up time is related to the time spent in power-down mode; shorter power-down cycles result in proportionally shorter wake-up times. When using the SPI port interface, the user can place the ADC in power-down mode or standby mode. Standby mode allows the user to keep the internal reference circuitry powered when faster wake-up times are required. See the Memory Map section for more information about using these features.


Figure 63. Total Power vs. $f_{\text {SAMPLE }}$ for $f_{I N}=9.7 \mathrm{MHz}$, Four Channels ( $V_{\text {REF }}=1.4 \mathrm{~V}$ )


Figure 64. Total Power vs. $f_{\text {SAMPLE }}$ for $f_{I N}=9.7 \mathrm{MHz}$, Four Channels $\left(V_{\text {REF }}=1.0 \mathrm{~V}\right)$

## DIGITAL OUTPUTS

## JESD204B Transmit Top Level Description

The AD9656 digital output uses the JEDEC Standard No. JESD204B, Serial Interface for Data Converters. JESD204B is a protocol to link the AD9656 to a digital processing device over a serial interface with link speeds up to 8.0 Gbps . The benefits of the JESD204B interface include a reduction in the required board area for data interface routing and the enabling of smaller packages for converter and logic devices. The AD9656 supports single, dual, and four lane interfaces.

## JESD204B Overview

The JESD204B data transmit block, JTX, assembles the parallel data from the ADC into frames and uses $8 \mathrm{~b} / 10 \mathrm{~b}$ encoding, as well as optional scrambling, to form serial output data. Lane synchronization is supported using special characters during the initial establishment of the link, and additional synchronization is embedded in the data stream thereafter. A matching external receiver is required to lock onto the serial data stream and recover the data and clock. For additional information about the JESD204B interface, refer to the JESD204B standard.
The AD9656 JESD204B transmit block maps the output of the four ADCs over a link. A link can be configured to use either single, dual, or four serial differential outputs, which are called lanes. The JESD204B specification refers to a number of parameters to define the link, and these parameters must match between the JESD204B transmitter (AD9656 output) and receiver.

The JESD204B link is described according to the following parameters:

- $S$ = samples transmitted/single converter/frame cycle (AD9656 value $=1$ )
- $\quad \mathrm{M}=$ number of converters/converter device (AD9656 value $=4$ )
- $\mathrm{L}=$ number of lanes/converter device $(\mathrm{AD} 9656$ value $=$ 1,2 , or 4)
- $\mathrm{N}=$ converter resolution $(\mathrm{AD} 9656$ value $=16)$
- $\quad \mathrm{N}^{\prime}=$ total number of bits per sample (AD9656 value $=16$ )
- $\quad \mathrm{CF}=$ number of control words/frame clock cycle/converter device $($ AD9656 value $=0)$
- $\mathrm{CS}=$ number of control bits/conversion sample (AD9656 value $=0$ )
- $K=$ number of frames per multiframe (configurable on the AD9656)
- $\mathrm{HD}=$ high density mode $(\mathrm{AD} 9656$ value $=0)$
- $\mathrm{F}=$ octets/frame (AD9656 value $=2$, 4 , or 8 , dependent upon $L=4,2$, or 1 )
- $\mathrm{C}=$ control bit (overrange, overflow, underflow; unavailable in the AD9656 default mode)
- $\mathrm{T}=$ tail bit (unavailable in the AD9656 default mode)
- $\mathrm{SCR}=$ scrambler enable/disable (configurable on the AD9656)
- $\quad$ FCHK = checksum for the JESD204B parameters (automatically calculated and stored in the register map)


## JESD204B Configurations

Figure 68 shows a simplified conceptual block diagram of the AD9656 JESD204B link. By default, the AD9656 is configured to use four converters and one lane. The AD9656 allows for other configurations such as combining the outputs of two of the four converters onto a single lane resulting in the data from the four converters being output on two lanes. The mapping of the 0,1 , 2 , and 3 digital output paths can be changed. These modes are set up through a quick configuration register in the SPI register map, along with additional customizable options.
By default in the AD9656, the 16-bit word from each converter is divided into two octets ( 8 bits of data each). Bit 0 (MSB) through Bit 7 are in the first octet and Bit 8 through Bit 15 (LSB) are the second octet.

The two resulting octets can be scrambled. Scrambling is optional; however, it is available to avoid spectral peaks when transmitting similar digital data patterns. The scrambler uses a self synchronizing, polynomial-based algorithm defined by the equation $1+x^{14}+x^{15}$. The descrambler in the receiver must be a self synchronizing version of the scrambler polynomial.
The two octets are then encoded with an $8 \mathrm{~b} / 10 \mathrm{~b}$ encoder. The 8b/10b encoder works by taking eight bits of data (an octet) and encoding them into a 10 -bit symbol. Figure 69 shows how the 16 -bit data is output from the ADC , the two octets are scrambled, and how the octets are encoded into two 10-bit symbols. Figure 69 illustrates the default data format.
At the data link layer, in addition to the $8 \mathrm{~b} / 10 \mathrm{~b}$ encoding, character replacement allows the receiver to monitor frame alignment. The character replacement process occurs on the frame and multiframe boundaries, and implementation depends on which boundary is occurring and if scrambling is enabled.

If scrambling is disabled, the following applies. If the last scrambled octet of the last frame of the multiframe equals the last octet of the previous frame, the transmitter replaces the last octet with the control character $/ \mathrm{A} /=/ \mathrm{K} 28.3 /$. On other frames within the multiframe, if the last octet in the frame equals the last octet of the previous frame, the transmitter replaces the last octet with the control character /F/=/K28.7/.

If scrambling is enabled, the following applies. If the last octet of the last frame of the multiframe equals $0 x 7 \mathrm{C}$, the transmitter replaces the last octet with the control character $/ \mathrm{A} /=/ \mathrm{K} 28.3 /$. On other frames within the multiframe, if the last octet equals 0 xFC , the transmitter replaces the last octet with the control character /F/ = /K28.7/.
Refer to JEDEC Standard No. JESD204B (July 2011) for additional information about the JESD204B interface. Section 5.1 covers the transport layer and data format details, and Section 5.2 covers scrambling and descrambling.

## Initial JESD204B Link Startup

The power-on default JESD204B state of the AD9656 is M4L1. Once the ADC is configured and the appropriate clocks are provided, any JESD204B parameters different from the default configuration must be set prior to enabling the link. Figure 65 depicts the start-up and synchronization timing of the AD9656 JESD204B Tx in subclass 1 mode. It is recommended that the SYNCINB signal (defined as SYNC~, according to the JESD204B standard) is asserted at power-up and must not be deasserted until after SYSREF has been applied according to the timing illustrated in the figure. Once the PLL has settled the serial outputs on each lane, begin to toggle between 1's and 0's. Shortly thereafter ( 13 frame clock cycles), K28.5 characters are sent across the link on each lane and the local multiframe clock (LMFC) is generated. At this time SYSREF can be applied.


Figure 65. JESD204B Tx Start-Up and Synchronization Timing

## Resynchronization

Figure 66 depicts the resynchronization timing for the AD9656 JESD204B interface. When the subclass 1 receiving logic device is ready to resynchronize, it asserts the SYNCINB signal and issues a SYSREF request. Note that once SYSREF is applied, the JESD204B internal clocks are reset and take up to 2 LMFC periods to fully settle.


## JESD204B Synchronization Details

The AD9656 is a JESD204B Subclass 1 device and establishes synchronization of the link through two control signals (SYSREF and SYNCINB). At the system level, multiple converter devices are aligned using a common SYSREF signal and device clock (CLK).
The synchronization process is accomplished over three phases: code group synchronization (CGS), initial lane alignment sequence (ILAS), and data transmission. If scrambling is enabled, the bits are not scrambled until the data transmission phase. The CGS phase and ILAS phase do not use scrambling.

## CGS Phase

The assertion of the SYNCINB signal by the JESD204B Rx for more than 5 frames and 9 octets informs the JESD204B Tx to synchronize. To have the AD9656 to respond by initiating the CGS phase, the SYNCINB signal must be asserted for at least 4 LMFC cycles if no SYSREF realignment is required. As illustrated in Figure 66, if SYSREF realignment is needed, the SYNCINB signal must be asserted for at least 6 LMFC cycles. In the CGS phase, the JESD204B transmit block transmits /K28.5/ characters. The receiver (external logic device) must find K28.5 characters in the input data stream using clock and data recovery (CDR) techniques.

When a certain number of consecutive K28.5 characters are detected on the link lanes, the receiver initiates a SYSREF edge so that the AD9656 transmit data establishes a LMFC internally.
The SYSREF edge also resets any sampling edges within the ADC to align sampling instances to the LMFC. This is important to maintain synchronization across multiple devices.
The receiver or logic device deasserts the SYNCINB signal applied to the SYNCINB $\pm$ pin according to the previously stated timing requirements.

## ILAS Phase

The ILAS phase begins on the second LMFC boundary after SYNCINB is deasserted; and the ILAS phase contents are as illustrated in Figure 67. The transmitter sends out the ILAS according to the JESD204B standard, and the receiver aligns all lanes of the link and verifies the parameters of the link.

The ILAS phase lasts for four multiframes and includes the following:

- Multiframe 1: Begins with an /R/ character [K28.0] and ends with an /A/ character [K28.3].
- Multiframe 2: Begins with an /R/ character followed by a /Q/ [K28.4] character, followed by link configuration parameters over 14 configuration octets (see Table 12), and ends with an / $\mathrm{A} /$ character.
- Multiframe 3: same as Multiframe 1.
- Multiframe 4: same as Multiframe 1.

During the transmission of the ILAS, all data that is not a K28 control character or a configuration parameter is a repeating ramp pattern from 0 to 255 . In the default state ( $\mathrm{M}=4, \mathrm{~L}=1, \mathrm{~K}=32$ ), there are 256 octets per multiframe, which allows the ramp to complete within Multiframe 1, 3, and 4. For configurations with less than 256 octets per multiframe, the ramp continues to rise into the next multiframe. Multiframe 2 has 14 configuration octets following a /Q/ character that is transmitted instead of ramp values. The ramp continues to advance internally while the 14 configuration octets are transmitted and ramp values appear again after the 14 configuration octets end.


Figure 67. ILAS Data Sequence, $M=4, L=1, K=32$

Table 12. 14 Configuration Octets of the ILAS Phase

| No. | Bit 7 <br> (MSB) | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | $\begin{aligned} & \text { Bit } 0 \\ & \text { (LSB) } \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | DID[7:0] |  |  |  |  |  |  |  |
| 1 |  |  |  |  | BID[3:0] |  |  |  |
| 2 |  |  |  | LID[4:0] |  |  |  |  |
| 3 | SCR |  |  | L[4:0] |  |  |  |  |
| 4 | F[7:0] |  |  |  |  |  |  |  |
| 5 |  |  |  | K[4:0] |  |  |  |  |
| 6 | M[7:0] |  |  |  |  |  |  |  |
| 7 | CS[1:0] |  |  | N[4:0] |  |  |  |  |
| 8 | SUBCLASS[2:0] |  |  | N'[4:0] |  |  |  |  |
| 9 | JESDV[2:0] |  |  | S[4:0] |  |  |  |  |
| 10 |  |  |  | CF[4:0] |  |  |  |  |
| 11 | Reserved, don't care (RES1) |  |  |  |  |  |  |  |
| 12 | Reserved, don't care (RES2) |  |  |  |  |  |  |  |
| 13 | FCHK[7:0] |  |  |  |  |  |  |  |

## Data Transmission Phase

In the data transmission phase, frame alignment is monitored with control characters. Character replacement is used at the end of frames. Character replacement in the transmitter occurs in the following instances:

- If scrambling is disabled and the last octet of the frame or multiframe equals the octet value of the previous frame.
- If scrambling is enabled and the last octet of the multiframe is equal to $0 \times 7 \mathrm{C}$, or the last octet of a frame is equal to 0 xFC .


## Link Setup Parameters

The following demonstrates how to configure the AD9656 JESD204B interface. The steps to configure the output include the following:

1. Disable the lanes before changing configuration.
2. Select one quick configuration option.
3. Configure the detailed options.
4. Check FCHK, checksum of JESD204B interface parameters.
5. Set additional digital output configuration options.
6. Reenable the lane(s).

## Disable Lanes Before Changing Configuration

Before modifying the JESD204B link parameters, disable the link and hold it in reset. This is accomplished by writing Logic 1 to Register 0x5F, Bit 0.

## Select Quick Configuration Option

Write to Register 0x5E, the JESD204B quick configuration register to select the configuration options. See Table 15 for the configuration options and resulting JESD204B parameter values.

- $0 \times 41=$ four converters, one lane
- $0 \times 42=$ four converters, two lanes
- $0 \times 44=$ four converters, four lanes
- $0 \times 21=$ two converters, one lane
- $0 x 22=$ two converters, two lanes
- 0 x11 = one converter, one lane


## Configure Detailed Options

Configure the tail bits and control bits.

- With $\mathrm{N}^{\prime}=16$ and $\mathrm{N}=14$ (nondefault configuration), two bits are available per sample for transmitting additional information over the JESD204B link. The options are tail bits or control bits. By default, tail bits of 0 b 00 value are used.
- Tail bits are dummy bits sent over the link to complete the two octets and do not convey any information about the input signal. Tail bits can be fixed zeros (default) or pseudorandom numbers (Register 0x5F, Bit 6).
- One or two control bits can be selected to replace the tail bits using Register 0x72, Bits[7:6]. The meaning of the control bits can be set using Register 0x14, Bits[7:5].

Set lane identification values.

- JESD204B allows parameters to identify the device and lane. These parameters are transmitted during the ILAS phase, and they are accessible in the internal registers.
- The three identification values are device identification (DID), bank identification (BID), and lane identification (LID). DID and BID are device specific; therefore, they can be used for link identification.

Set the number of frames per multiframe, K .

- Per the JESD204B specification, a multiframe is defined as a group of $K$ successive frames, where $K$ is from 1 to 32 , and requires that the number of octets be from 17 to 1024 . The $K$ value is set to 32 by default in Register 0x70, Bits[4:0]. Note that the K value is the register value plus 1 .
- The K value can be changed; however, it must comply with a few conditions. The AD9656 uses a fixed value for octets per frame (F) based on the JESD204B quick configuration setting. K must also be a multiple of 4 and conform to the following equation:
$32 \geq K \geq \operatorname{Ceil}(17 / F)$
- The JESD204B specification also specifies that the number of octets per multiframe $(\mathrm{K} \times \mathrm{F})$ be from 17 to 1024 . The F value is fixed through the quick configuration setting to ensure that this relationship is true.

Table 13. JESD204B Configurable Identification Values

| DID Value | Register, Bits | Value Range |
| :--- | :--- | :--- |
| LID (Lane 0) | $0 \times 66,[4: 0]$ | $0 \ldots 31$ |
| LID (Lane 1) | $0 \times 67,[4: 0]$ | $0 \ldots 31$ |
| DID | $0 \times 64,[7: 0]$ | $0 \ldots 255$ |
| BID | $0 \times 65,[3: 0]$ | $0 \ldots 15$ |

Scramble, SCR.

- Scrambling can be enabled or disabled by setting Register 0x6E, Bit 7. By default, scrambling is enabled. Per the JESD204B protocol, scrambling is functional only after the lane synchronization has completed.
Select lane synchronization options.

Most of the synchronization features of the JESD204B interface are enabled by default for typical applications. In some cases, these features can be disabled or modified as follows:

- ILAS enabling is controlled in Register 0x5F, Bits[3:2] and is enabled by default. Optionally, to support some unique instances of the interfaces (such as NMCDA-SL), the JESD204B interface can be programmed to either disable the ILAS sequence or continually repeat the ILAS sequence.

The AD9656 has fixed values for some JESD204B interface parameters, and they are as follows:

- $\quad\left[\mathrm{N}^{\prime}\right]=16:$ number of bits per sample is 16 , in Register 0x73, Bits[4:0]
- $\quad[C F]=0$ : number of control words/frame clock cycle/converter is 0 , in Register 0x75, Bits[4:0]
Verify read only values: lanes per link (L), octets per frame (F), number of converters (M), and samples per converter per frame (S). The AD9656 calculates values for some JESD204B parameters based on other settings, particularly the quick configuration register selection. The following read only values are available in the register map for verification:
- $\quad[\mathrm{L}]=$ lanes per link can be 1,2 or 4 ; read the values from Register 0x6E, Bits [4:0]
- $\quad[\mathrm{F}]=$ octets per frame can be 2,4 , or 8 ; read the value from Register 0x6F, Bits[7:0]
- $\quad[\mathrm{HD}]=$ high density mode is 0 ; read the value from Register 0x75, Bit 7
- $\quad[\mathrm{M}]=$ number of converters per link; default is 4 , but can be 1, 2, or 4 . Read the value from Register 0x71, Bits[7:0]
- $\quad[S]=$ samples per converter per frame is 1 ; read the value from Register 0x74, Bits[4:0]


## Check FCHK, Checksum of JESD204B Interface Parameters

The JESD204B parameters can be verified through the checksum value [FCHK] of the JESD204B interface parameters. Each lane has a FCHK value associated with it. The FCHK value is transmitted during the ILAS second multiframe and can be read from the internal registers.
The checksum value is the modulo 256 sum of the parameters listed in the No. column of Table 14. The checksum is calculated by adding the parameter fields before they are packed into the octets shown in Table 14.

The FCHK for the lane configuration for data exiting Lane 0 can be read from Register 0x78. Similarly, the FCHK for the lane configuration for data exiting Lane 1 can be read from Register $0 x 79$, FCHK for Lane 2 can be read from Register 0x7A, and FCHK for Lane 3 can be read from Register 0x7B.

Table 14. JESD204B Configuration Table Used in ILAS and CHKSUM Calculation

| No. | Bit 7 <br> (MSB) | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | $\begin{aligned} & \hline \text { Bit } 0 \\ & \text { (LSB) } \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | DID[7:0] |  |  |  |  |  |  |  |
| 1 |  |  |  |  | BID[3:0] |  |  |  |
| 2 |  |  |  | LID[4:0] |  |  |  |  |
| 3 | SCR |  |  | L[4:0] |  |  |  |  |
| 4 | F[7:0] |  |  |  |  |  |  |  |
| 5 |  |  |  | K[4:0] |  |  |  |  |
| 6 | M[7:0] |  |  |  |  |  |  |  |
| 7 | CS[1:0] |  |  | N[4:0] |  |  |  |  |
| 8 | SUBCLASS[2:0] |  |  | N'[4:0] |  |  |  |  |
| 9 | JESDV[2:0] |  |  | S[4:0] |  |  |  |  |
| 10 |  |  |  | CF[4:0] |  |  |  |  |

## Set Additional Digital Output Configuration Options

Other data format controls include the following:

- Invert polarity of serial output data: Register 0x60, Bit 1
- ADC data format (offset binary or twos complement): Register 0x14, Bits[1:0]
- Options for interpreting signals on the SYSREF $\pm$ and SYNCINB $\pm$ pins: Register 0x3A, Bits[4:3]
- Option to remap converter (logical lane) and SERDOUTx $\pm$ (physical lane) assignments: Register 0x82 and Register 0x83. See Figure 68 for a simplified conceptual block diagram.


## Reenable Lanes After Configuration

After modifying the JESD204B link parameters, enable the link so that the synchronization process can begin. This is accomplished by writing Logic 0 to Register 0x5F, Bit 0 .

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Figure 68. AD9656 Transmit Link Simplified Conceptual Block Diagram


Figure 69. AD9656 Digital Processing of JESD204B Lanes
Table 15. AD9656 JESD204B Typical Configurations


Figure 70. AD9656 ADC Output Data Path
Table 16. AD9656 JESD204B Frame Alignment Monitoring and Correction Replacement Characters

| Scrambling | Lane Synchronization | Character to be Replaced | Last Octet in <br> Multiframe | Replacement Character |
| :--- | :--- | :--- | :--- | :--- |
| Off | On | Last octet in frame repeated from previous frame | No | K28.7 |
| Off | On | Last octet in frame repeated from previous frame | Yes | K28.3 |
| Off | Off | Last octet in frame repeated from previous frame | Not applicable | K28.7 |
| On | On | Last octet in frame equals D28.7 | No | K28.7 |
| On | On | Last octet in frame equals D28.3 | Yes | K28.3 |
| On | Off | Last octet in frame equals D28.7 | Not applicable | K28.7 |

## Frame and Lane Alignment Monitoring and Correction

Frame alignment monitoring and correction is part of the JESD204B specification. The 16 -bit word requires two octets to transmit all the data. The two octets (MSB and LSB), where F $=2$, make up a frame. During normal operating conditions, frame alignment is monitored via alignment characters, which are inserted under certain conditions at the end of a frame. Table 16 summarizes the conditions for character insertion, along with the expected characters under the various operation modes. If lane synchronization is enabled, the replacement character value depends on whether the octet is at the end of a frame or at the end of a multiframe.
Based on the operating mode, the receiver can ensure that it is still synchronized to the frame boundary by correctly receiving the replacement characters.

## Digital Outputs and Timing

The AD9656 has differential digital outputs that power up by default. The driver current is derived on chip and sets the output current at each output equal to a nominal 3 mA . Each output presents a $100 \Omega$ dynamic internal termination to reduce unwanted reflections.

The AD9656 digital outputs can interface with custom ASICs and FPGA receivers, providing superior switching performance in noisy environments. Single point to point network topologies are recommended with a single differential $100 \Omega$ termination resistor placed as close to the receiver logic as possible.

For receiver inputs that are self biased, or with input common mode requirements not within the bounds of the AD9656 DRVDD supply, use an ac-coupled connection as shown in Figure 71. Place a $0.1 \mu \mathrm{~F}$ series capacitor on each output pin and use a $100 \Omega$ differential termination close to the receiver side. The $100 \Omega$ differential termination results in a nominal 600 mV p-p differential swing at the receiver. In the case where the receiver inputs are not self biased, single-ended $50 \Omega$ terminations can be used. When single-ended terminations are used, the termination voltage ( $\mathrm{V}_{\mathrm{RXCM}}$ ) must be chosen to match the input requirements of the receiver.


Figure 71. AC-Coupled Digital Output Termination Example

For receivers with input common mode voltage requirements matching the output common mode voltage (DRVDD/2) of the AD9656, a dc-coupled connection can be used. The common mode of the digital output automatically biases itself to half of DRVDD ( 0.9 V for DRVDD $=1.8 \mathrm{~V}$ ) (see Figure 72).


Figure 72. DC-Coupled Digital Output Termination Example
If there is no far-end receiver termination, or if there is poor differential trace routing, timing errors can result. To avoid such timing errors, it is recommended that the trace length be less than six inches and the differential output traces be close together and of equal lengths.
Figure 73 shows an example of the digital output data eye and time interval error (TIE) jitter histogram and bathtub curve for an AD9656 lane running at 6.4 Gbps .
The maximum allowable data rate per lane is 8 Gbps . In some configurations, the AD9656 maximum conversion rate is limited by the maximum allowable data rate. The output data rate per lane is calculated as follows:

$$
\text { Data Rate }=(M \times N \times(10 / 8) \times \text { Sample Rate }) / L
$$

where M (number of converters), N (resolution), and L (Number of lanes) are defined in the JESD204B Overview section. For example, with $M=4, N=16$, and $L=1$;-the sample rate is limited to 100 Msps.
Additional SPI options allow the user to further increase the output driver voltage swing of all four outputs to drive longer trace lengths (see Register 0x15 in Table 19). The power dissipation of the DRVDD supply increases when this option is used. See the Memory Map section for more information.

The format of the output data is twos complement by default. To change the output data format to offset binary, see the Memory Map section and Register 0x14 in Table 19.


Figure 73. AD9656 Digital Outputs Data Eye, Histogram, and Bathtub, External $100 \Omega$ Terminations at 6.4 Gbps

## SERIAL PORT INTERFACE (SPI)

The AD9656 SPI allows the user to configure the converter for specific functions or operations through a structured register space provided inside the ADC. The SPI gives the user added flexibility and customization, depending on the application. Addresses are accessed via the serial port and can be written to or read from via the port. Memory is organized into bytes that can be further divided into fields. These fields are documented in the Memory Map section. For general operational information, see the AN-877 Application Note, Interfacing to High Speed ADCs via SPI.

## CONFIGURATION USING THE SPI

Three pins define the SPI of this ADC: the SCLK pin, the SDIO pin, and the CSB pin (see Table 17). The SCLK pin synchronizes the read and write data presented from/to the ADC. The SDIO pin is a dual purpose pin that allows data to be sent and read from the internal ADC memory map registers. The CSB pin is an active low control that enables or disables the read and write cycles.

Table 17. Serial Port Interface Pins

| Pin | Function |
| :--- | :--- |
| SCLK | Serial Clock. The serial shift clock input, which <br> synchronizes serial interface reads and writes. |
| SDIO | Serial Data Input/Output. A dual purpose pin that <br> typically serves as an input or an output, depending on <br> the instruction being sent and the relative position in the <br> timing frame. |
| CSB | Chip Select Bar. An active low control that gates the read <br> and write cycles. |

The falling edge of CSB, in conjunction with the rising edge of SCLK, determines the start of the framing. An example and definition of the serial timing can be found in Figure 74 and Table 7.

Other modes involving the CSB pin are available. The CSB pin can be held low indefinitely, which permanently enables the device; this is called streaming. The CSB pin can stall high between bytes to allow for additional external timing. When CSB is tied high, SPI functions are placed in a high impedance mode. This mode turns on any SPI pin secondary functions.
During an instruction phase, a 16-bit instruction is transmitted. Data follows the instruction phase and the length is determined by the W0 and W1 bits.
All data is composed of 8 -bit words. The first bit of each individual byte of serial data indicates whether a read or write command is issued. This allows the SDIO pin to change direction from an input to an output.
In addition to word length, the instruction phase determines whether the serial frame is a read or write operation, allowing the serial port to be used both to program the chip and to read the contents of the on-chip memory.

If the instruction is a readback operation, performing a readback causes the SDIO pin to change direction from an input to an output at the appropriate point in the serial frame.
Input data is registered on the rising edge of SCLK and output data is transmitted on the falling edge. After the address information passes to the converter that is requesting a read, the SDIO line transitions from an input to an output within one-half of a clock cycle. This timing ensures that when the falling edge of the next clock cycle occurs, data can be safely placed on this serial line for the controller to read.

Data can be sent in MSB first mode or in LSB first mode. MSB first is the default on power-up and can be changed via the SPI port configuration register. For more information about this and other features, see the AN-877 Application Note, Interfacing to High Speed ADCs via SPI.

## HARDWARE INTERFACE

The pins described in Table 17 make up the physical interface between the user programming device and the serial port of the AD9656. The SCLK pin and the CSB pin function as inputs when using the SPI interface. The SDIO pin is bidirectional, functioning as an input during write phases and as an output during readback.
The AD9656 has a separate supply pin for the SPI interface, SVDD. The SVDD pin can be set to any level between 1.8 V and 3.3 V to enable operation with a SPI bus at these voltages without requiring level translation. If the SPI port is not used, SVDD can be tied to the DRVDD voltage.
The SPI interface is flexible enough to be controlled by either FPGAs or microcontrollers. One method for SPI configuration is described in detail in the AN-812 Application Note, Microcontroller-Based Serial Port Interface (SPI) Boot Circuit.

When the full dynamic performance of the converter is required, do not activate the SPI port. Because the SCLK signal, the CSB signal, and the SDIO signal are typically asynchronous to the ADC clock, noise from these signals can degrade converter performance. If the on-board SPI bus is used for other devices, it may be necessary to provide buffers between this bus and the AD9656 to prevent these signals from transitioning at the converter inputs during critical sampling periods.

## SPI ACCESSIBLE FEATURES

Table 18 provides a brief description of the features that are accessible via the SPI. These features are described in general in the AN-877 Application Note, Interfacing to High Speed ADCs via SPI. The AD9656 device-specific features are described in the Memory Map Register Descriptions section. Information in the AD9656 data sheet takes precedence over information in AN-877 Application Note, where it relates to the AD9656.

Table 18. Features Accessible Using the SPI


Figure 74. Serial Port Interface Timing Diagram

## MEMORY MAP

## READING THE MEMORY MAP REGISTER TABLE

Each row in the memory map register table has eight bit locations. The memory map is roughly divided into three sections: the chip configuration registers (Address $0 \times 00$ to Address 0x02); the channel index and transfer registers (Address 0x05 and Address 0xFF); and the ADC functions registers, including setup, control, and test (Address 0x08 to Address 0x10A).

The memory map register table (see Table 19) documents the default hexadecimal value for each hexadecimal address shown. The column with the heading Bit 7 (MSB) is the start of the default hexadecimal value given. For example, Address 0x14, the output mode register, has a hexadecimal default value of $0 x 01$. This means that Bit $0=1$ and the remaining bits are 0 s. This setting is the default output format value, which is twos complement. For general information on this function and others, see the AN-877 Application Note, Interfacing to High Speed ADCs via SPI. See Table 19 for SPI register information specific to the AD9656.

## Open and Reserved Locations

All address and bit locations that are not included in Table 19 are not supported for this device. Write 0 s to unused bits of a valid address location. Writing to these locations is required only when part of an address location is open (for example, Address 0x18). If the entire address location is open (for example, Address 0x13), do not write to this address location.

## Default Values

After the AD9656 is reset, critical registers are loaded with default values. The default values for the registers are given in the memory map register table (see Table 19).

## Logic Levels

An explanation of logic level terminology follows:

- "Bit is set" is synonymous with "bit is set to Logic 1" or "writing Logic 1 for the bit."
- "Clear a bit" is synonymous with "bit is set to Logic 0 " or "writing Logic 0 for the bit."


## Channel Specific Registers

Some channel setup functions can be programmed to a different value for each channel. In these cases, channel address locations are internally duplicated for each channel. These registers and bits are designated in Table 19 as local. These local registers and bits can be accessed by setting the appropriate Channel 0 , Channel 1 , Channel 2, or Channel 3 bit in Register 0x05. If four bits are set, the subsequent write affects the registers of all four channels. In a read cycle, set only one of the channels to read one of the four registers. If all bits are set during an SPI read cycle, the device returns the value for Channel 0 . Registers and bits designated as global in Table 19 affect the entire device and the channel features for which independent settings are not allowed between channels. The settings in Register 0x05 do not affect the global registers and bits.

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## MEMORY MAP REGISTER TABLE

The AD9656 uses a 3 -wire interface and 16 -bit addressing. Bit 0 and Bit 7 in Register $0 \times 00$ are set to 0 , and Bit 3 and Bit 4 are set to 1 . When Bit 5 in Register 0x00 is set high, the SPI enters a soft reset, where all of the user registers revert to each default value and Bit 2 is automatically cleared.

Table 19. Memory Map Registers (SPI Registers/Bits Not Labeled Local Are Global)

| Addr (Hex) | Register Name | $\begin{aligned} & \text { Bit } 7 \\ & \text { (MSB) } \end{aligned}$ | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 (LSB) | Default Value <br> (Hex) | Notes/ Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Chip Configuration Registers |  |  |  |  |  |  |  |  |  |  |  |
| 0x00 | SPI port configuration | 0 | LSB first | Soft reset | 1 | 1 | Soft reset | LSB first | 0 | 0x18 |  |
| 0x01 | Chip ID | 8-bit chip ID[7:0]; AD9656 = 0xC0 (quad, 16-bit, 125 MSPS, JESD204B) |  |  |  |  |  |  |  | 0xC0 | Read only. |
| 0x02 | Chip grade | Open | Speed grade ID[6:4]; $110=125$ MSPS |  |  | Open | Open | Open | Open | 0x62 | Read only. |
| Channel Index and Transfer Registers |  |  |  |  |  |  |  |  |  |  |  |
| 0x05 | Device index | Open | Open | Open | Open | Data Channel 3 | Data Channel 2 | Data Channel 1 | Data <br> Channel 0 | 0x0F |  |
| 0xFF | Transfer | Open | Open | Open | Open | Open | Open | Open | Initiate <br> Register <br> 0x100 <br> override <br> (self <br> clearing) | 0x00 |  |
| ADC Functions |  |  |  |  |  |  |  |  |  |  |  |
| 0x08 | Power modes | Open | Open | PDWN pin function: $0=$ full powerdown, $1=$ standby | JTX standby mode: $0=$ ignore standby, $1=$ do not ignore standby | Reserved |  | $\begin{aligned} & \text { Power mode: } \\ & 00=\text { normal operation, } \\ & 01=\text { full power-down, } \\ & 10=\text { standby, } \\ & 11=\text { digital reset } \end{aligned}$ |  |  |  |
| 0x09 | Clock | Open | 0 | Open | Open | Open | Open | Open | Duty cycle stabilizer: $\begin{aligned} & 0=\text { off }, \\ & 1=\text { on } \end{aligned}$ | 0x00 |  |
| 0x0A | PLL_STATUS | PLL locked status bit: $0=$ PLL is not locked, 1 = PLL is locked | Open | Open | Open | Open | Open | Open | JTX link status: $0=\text { not }$ <br> ready, $1 \text { = ready }$ |  | Read only. |
| 0x0B | Clock divider | Open | Open | Open | Open | Open | $\begin{aligned} & \text { Clock divider ratio[2:0]: } \\ & 000=\text { divide by } 1, \\ & 001=\text { divide by } 2, \\ & 010=\text { divide by } 3, \\ & 011=\text { divide by } 4, \\ & 100=\text { divide by } 5, \\ & 101=\text { divide by } 6, \\ & 110=\text { divide by } 7, \\ & 111=\text { divide by } 8 \\ & \hline \end{aligned}$ |  |  | 0x00 |  |
| 0x0C | Enhancement control | Open | Open | Open | Open | Open | Chop mode: $0=$ off, $1=$ on | Open | Open | 0x00 |  |
| 0x0D | Test mode (local except for pseudorandom number (PN) sequence resets) | User input test mode: $00 \text { = single, }$ <br> 01 = alternate, $10=$ single once, 11 = alternate once, (affects user input test mode only, Bits[3:0] = 1000) |  | Reset PN long generator | Reset PN short generator | $\begin{gathered} \text { Output test mode[3:0] (local): } \\ 0000=\text { off (default), } \\ 0001=\text { midscale short, } \\ 0010=\text { positive full scale (FS), } \\ 0011=\text { negative FS, } \\ 0100=\text { alternating checkerboard, } \\ 0101=\text { PN23 sequence, } \\ 0110=\text { PN9 sequence, } \\ 0111=\text { one/zero word toggle, } \\ 1000=\text { user input, } \\ 1001=1 / 0 \text { bit toggle, } \\ 1010=1 \times \text { sync, } \\ 1011=\text { one bit high, } \\ 1100=\text { mixed bit frequency } \\ \hline \end{gathered}$ |  |  |  | 0x00 | When set, the test data is placed on the output pins in place of normal data. |
| 0x10 | Offset adjust (local) | 8-bit device offset adjustment [7:0] (local); offset adjusts in LSBs from +127 to -128 (twos complement format) |  |  |  |  |  |  |  | 0x00 | Device offset trim. |


| Addr <br> (Hex) | Register Name | $\begin{aligned} & \text { Bit } 7 \\ & \text { (MSB) } \\ & \hline \end{aligned}$ | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 (LSB) | Default Value <br> (Hex) | Notes/ Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0x14 | Output mode | JTX CS mode: <br> $000=$ \{overrange $\\|$ underrange, valid flag $\}$, 001 = \{overrange, underrange\}, $010=$ \{overrange \|| underrange, blank\}, 011 = \{blank, valid flag\}, $100=$ \{blank, blank\}, <br> Others = \{overrange \|| underrange, valid flag\} |  |  | ADC output disable: $0=$ enabled, 1 = disabled (local) | Open | Open | Output format: $00=$ offset binary, $01=$ twos complement |  | 0x01 | Bits[7:5] are not applicable when using the default 16-bit resolution. |
| 0x15 | Output adjust | Open | Open | Open | Open | Open | Typical CML differential output drive level:$\begin{aligned} & 000=473 \mathrm{mV} \text { p-p, } \\ & 001=524 \mathrm{mV} \mathrm{p-p,} \\ & 010=574 \mathrm{mV}-\mathrm{p}, \end{aligned}$$\begin{aligned} & 011=621 \mathrm{mV} \mathrm{p}-\mathrm{p} \text { (default), } \\ & 100=667 \mathrm{mV} \mathrm{p}-\mathrm{p}, \\ & 101=716 \mathrm{mV} \mathrm{p-p,} \\ & 110=763 \mathrm{mV} \mathrm{p-p,} \\ & 111=811 \mathrm{mV} \mathrm{p-p} \end{aligned}$ |  |  | 0x03 |  |
| 0x16 | Clock phase control | Open | Input clock phase adjust[2:0] (value is number of input clock cycles of phase delay) |  |  | Open | Open | Open | Open | 0x00 |  |
| 0×18 | Input span select | Internal VREF adjustment[1:0]:$\begin{aligned} & 00=1.0 \mathrm{~V}, \\ & 01=1.2 \mathrm{~V}, \\ & 10=1.3 \mathrm{~V}, \\ & 11=1.4 \mathrm{~V} \end{aligned}$ |  | Open | Open | Open | Differential span adjustment: $000=50 \%$ of normal, $001=57 \%$ of normal, $010=67 \%$ of normal, $011=80 \%$ of normal, $100=$ normal |  |  | 0x04 |  |
| 0x19 | User Test <br> Pattern 1 LSB | User Test Pattern 1[7:0] |  |  |  |  |  |  |  | 0x00 |  |
| 0x1A | User Test <br> Pattern 1 MSB | User Test Pattern 1[15:8] |  |  |  |  |  |  |  | 0x00 |  |
| 0x1B | User Test <br> Pattern 2 LSB | User Test Pattern 2[7:0] |  |  |  |  |  |  |  | 0x00 |  |
| 0x1C | User Test <br> Pattern 2 MSB | User Test Pattern 2[15:8] |  |  |  |  |  |  |  | 0x00 |  |
| 0×21 | FLEX_SERIAL CONTROL | Open | Open | Open | Open | PLL low rate mode: $0=$ lane rate $\geq$ 2 Gbps 1 = lane rate < 2 Gbps | Open | Open | Open | 0x00 |  |
| 0×22 | $\begin{aligned} & \text { FLEX_SERIAL_ } \\ & \text { CH_STAT } \end{aligned}$ | Open | Open | Open | Open | Open | Open | Open | Channel powerdown (local) | $0 \times 00$ |  |
| 0x3A | SYSREF_CTRL | Open | Open | Open | $0=\text { normal }$ <br> mode, 1 = realign the lanes on every active SYNCINB $\pm$ | $0=$ <br> realign <br> the lanes <br> only <br> when <br> SYSREF $\pm$ <br> causes a <br> resync <br> of the <br> counters, $1=$ realign the lanes on every <br> SYSREF $\pm$ | Open | Open | Open | $0 \times 00$ |  |
| 0x3B | $\begin{aligned} & \hline \text { REALIGN_- } \\ & \text { PATTERN_CTRL } \end{aligned}$ | This pattern is written into the FIFO when a lane is being aligned: $00=$ lane outputs constant zero, $55=$ lane outputs toggling pattern |  |  |  |  |  |  |  | 0x55 |  |
| 0x5E | JESD204B quick configuration | $0 \times 41=$ four converters, one lane; $0 \times 42=$ four converters, two lanes; $0 \times 44=$ four converters, four lanes; $0 \times 22=$ two converters, two lanes; $0 \times 21=$ two converters, one lane; $0 \times 11=$ one converter, one lane |  |  |  |  |  |  |  | 0x00 | Self clearing, always reads $0 \times 00$. |

## AD9656

| Addr <br> (Hex) | Register Name | $\begin{aligned} & \text { Bit } 7 \\ & \text { (MSB) } \end{aligned}$ | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 (LSB) | Default Value <br> (Hex) | Notes/ Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0x5F | JESD204B Link CTRL 1 | Open | Tail bits mode: $0=$ fill with 0 s , $1=$ fill with 9-bit PN sequence | JTX transport layer test: $0=$ not enabled, 1 = long transport layer test enabled | Multiframe alignment character insertion: $0=$ disabled, 1 = enabled |  | LAS mode: <br> ILAS disabled, <br> = ILAS enabled <br> ormal mode), <br> always on (test mode) | Frame alignment character insertion: $0=$ enabled, 1 = disabled | $0=$ JTX <br> link <br> enabled, <br> 1 = JTX <br> link <br> disabled | 0x14 |  |
| 0x60 | JESD204B Link CTRL 2 | Reserved |  | SYNCINB $\pm$ pin invert: $0=$ not inverted, $1=$ inverted | SYNCINB $\pm$ <br> pin input <br> bias: <br> $0=$ <br> disabled, 1 = <br> enabled | Open | Open | ЛX output invert: $0=$ normal, 1 = inverted | Reserved | 0x10 |  |
| 0x61 | JESD204B Link CTRL 3 | Reserved | Reserved | Test data injection point: $01=10$-bit data injected at $8 \mathrm{~b} / 10 \mathrm{~b}$ encoder output, $10=8$-bit data at scrambler input |  | JTX test mode patterns: <br> $0000=$ normal operation (test mode disabled), 0001 = alternating checkerboard, $0010=1 / 0$ word toggle, 0011 = PN sequence PN23, $0100=$ PN sequence PN9, <br> $0101=$ continuous/repeat user test mode, $0110=$ single user test mode, <br> 0111 = reserved, <br> $000=$ modified RPAT test sequence ( 8 -bit data only), $1100=$ PN sequence PN7, 1101 = PN sequence PN15, other setting are unused |  |  |  | 0x00 |  |
| 0x62 | JESD204B Link $\text { CTRL } 4$ | Reserved |  |  |  |  |  |  |  | 0x00 |  |
| 0x64 | JESD204B DID configuration | Device identification (DID) $=$ C0 |  |  |  |  |  |  |  | 0xC0 | Read only. |
| 0x65 | JESD204B BID configuration | Open | Open | Open | Open | JTX bank identification (BID) number |  |  |  | 0x00 |  |
| 0x66 | JESD204B LID Configuration 0 | Open | Open | Open | JTX lane identification (LID) number for Lane 0 |  |  |  |  | 0x00 |  |
| 0x67 | JESD204B LID Configuration 1 | Open | Open | Open | JTX lane identification (LID) number for Lane 1 |  |  |  |  | 0x01 |  |
| 0x68 | JESD204B LID Configuration 2 | Open | Open | Open | JTX lane identification (LID) number for Lane 2 |  |  |  |  | 0x02 |  |
| 0x69 | JESD204B LID Configuration 3 | Open | Open | Open | JTX lane identification (LID) number for Lane 3 |  |  |  |  | 0x03 |  |
| 0x6E | JESD204B parameters, SCR/L | JESD204B scrambling (SCR): $0=$ disabled, $1=$ enabled | Open | Open | JESD204B serial lane control: $0=$ one lane per link ( $L=1$ ), <br> $1=$ two lanes per link ( $L=2$ ), <br> 2 = unused, <br> 3 = four lanes per link ( $L=4$ ), <br> 4 to 31 = unused |  |  |  |  | 0x80 |  |
| 0x6F | JESD204B <br> parameters, F | JESD204B number of octets per frame (F); calculated value, $\mathrm{F}=(2 \times \mathrm{M}) / \mathrm{L}$ |  |  |  |  |  |  |  | 0x00 | Read only. |
| 0x70 | JESD204B parameters, K | Open | Open | Open | JESD204B number of frames per multiframe ( K ); $\mathrm{K}=$ register contents + 1 , but also must be a multiple of four octets |  |  |  |  | 0x1F |  |
| 0x71 | JESD204B parameters, M | JESD204B number of converters (M): $0=$ one converter ( $M=1$ ), $1=$ two converters ( $M=2$ ), $3=$ four converters ( $M=4$, default) |  |  |  |  |  |  |  | 0x03 |  |
| 0x72 | JESD204B parameters, CS/N | $\begin{gathered} \hline 00=\text { number of } \\ \text { control bits } \\ \text { sent per sample }(C S=0) \end{gathered}$ |  | Open | $\begin{gathered} \hline \text { JTX converter resolution (N): } \\ 0 \times 0 \mathrm{~F}=16 \text {-bit, } \\ 0 \times 0 \mathrm{D}=14 \text {-bit, } \\ 0 \times 0 \mathrm{~B}=12 \text {-bit, } \\ 0 \times 09=10 \text {-bit } \end{gathered}$ |  |  |  |  | 0x0F |  |
| 0x73 | JESD204B parameters, subclass/Np | $\begin{gathered} \text { JESD204B subclass; } \\ 0 \times 0=\text { Subclass } 0 ; \\ 0 \times 1=\text { Subclass } 1 \text { (default) } \end{gathered}$ |  |  | JESD204B number of bits per sample ( $\mathrm{N}^{\prime}$ ); $\mathrm{N}^{\prime}=$ register contents + 1 |  |  |  |  | 0x2F |  |
| 0x74 | JESD204B parameters, S | Reserved |  |  | JESD204B converter samples per frame (S); S = register contents + 1 |  |  |  |  | 0×20 | Read only. |
| 0x75 | JESD204B parameters, HD and CF | $\begin{aligned} & \text { JESD204B } \\ & \text { HD } \\ & \text { value }=0 \end{aligned}$ | Open | Open | JESD204B control words per frame clock cycle per link (CF = 0, fixed) |  |  |  |  | 0x00 | Read only. |
| 0x76 | $\begin{aligned} & \hline \text { JESD204B } \\ & \text { RESV1 } \\ & \hline \end{aligned}$ | JESD204B Serial Reserved Field No. 1 in link configuration, see Table 12 (RES1) |  |  |  |  |  |  |  | 0x00 |  |
| 0x77 | $\begin{aligned} & \hline \text { JESD204B } \\ & \text { RESV2 } \end{aligned}$ | JESD204B Serial Reserved Field No. 2 in link configuration, see Table 12 (RES2) |  |  |  |  |  |  |  | 0x00 |  |
| 0x78 | JESD204B CHKSUMO | JESD204B serial checksum value in link configuration, see Table 12 for Lane 0 (FCHK) |  |  |  |  |  |  |  |  | Read only. |

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| Addr (Hex) | Register Name | $\begin{aligned} & \text { Bit } 7 \\ & \text { (MSB) } \\ & \hline \end{aligned}$ | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 (LSB) | Default Value <br> (Hex) | Notes/ Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0x79 | $\begin{aligned} & \text { JESD204B } \\ & \text { CHKSUM1 } \end{aligned}$ | JESD204B serial checksum value in link configuration, see Table 12 for Lane 1 (FCHK) |  |  |  |  |  |  |  |  | Read only. |
| 0x7A | $\begin{aligned} & \text { JESD204B } \\ & \text { CHKSUM2 } \end{aligned}$ | JESD204B serial checksum value in link configuration, see Table 12 for Lane 2 (FCHK) |  |  |  |  |  |  |  |  | Read only. |
| 0x7B | $\begin{aligned} & \text { JESD204B } \\ & \text { CHKSUM3 } \end{aligned}$ | JESD204B serial checksum value in link configuration, see Table 12 for Lane 3 (FCHK) |  |  |  |  |  |  |  |  | Read only. |
| 0x80 | JTX physical lane disable | Open | Open | Open | Open | ```Lane 3: 0= enabled, 1= disabled``` | Lane 2: <br> $0=$ enabled, <br> 1 = disabled | ```Lane 1: 0= enabled, 1= disabled``` | $\begin{aligned} & \text { Lane } 0 \text { : } \\ & 0= \\ & \text { enabled, } \\ & 1= \\ & \text { disabled } \end{aligned}$ | 0x00 | Lane serialize and output driver powered down. |
| 0x82 | JESD204B Lane Assign 1 | Open | Physical Lane 1 assignment: <br> $000=$ Logical Lane 0 , <br> 001 = Logical Lane 1, <br> $010=$ Logical Lane 2, <br> 011 = Logical Lane 3 |  |  | Open | $\begin{gathered} \text { Physical Lane } 0 \text { assignment: } \\ 000=\text { Logical Lane 0, } \\ 001=\text { Logical Lane 1, } \\ 010=\text { Logical Lane 2, } \\ 011=\text { Logical Lane } 3 \end{gathered}$ |  |  | 0x10 |  |
| 0x83 | JESD204B Lane Assign 2 | Open | Physical Lane 3 assignment: <br> $000=$ Logical Lane 0, <br> $001=$ Logical Lane 1, <br> $010=$ Logical Lane 2, <br> 011 = Logical Lane 3 |  |  | Open | $\begin{gathered} \text { Physical Lane } 2 \text { assignment: } \\ 000=\text { Logical Lane 0, } \\ 001=\text { Logical Lane 1, } \\ 010=\text { Logical Lane 2, } \\ 011=\text { Logical Lane } 3 \end{gathered}$ |  |  | 0x32 |  |
| 0x86 | JESD204B lane inversion | Open | Open | Open | Open | Lane 3: $0=\text { no }$ <br> invert, <br> 1 = invert | $\begin{aligned} & \text { Lane 2: } \\ & 0=\text { no invert, } \\ & 1=\text { invert } \end{aligned}$ | Lane 1: $0=$ no invert, 1 = invert | Lane 0: $0=$ no invert, 1 = invert | 0x00 |  |
| 0x8B | $\begin{aligned} & \text { JESD204B } \\ & \text { LMFC offset } \end{aligned}$ | Open | Open | Open | Local multiframe clock (LMFC) phase offset value; reset value for LMFC phase counter when SYSREF $\pm$ is asserted; used for deterministic delay applications |  |  |  |  | 0x00 |  |
| 0xA0 | JTX User Pattern Octet 0, LSB | User test pattern least significant byte, Octet 0 |  |  |  |  |  |  |  | 0x00 |  |
| 0xA1 | JTX User Pattern Octet 0, MSB | User test pattern most significant byte, Octet 0 |  |  |  |  |  |  |  | 0x00 |  |
| 0xA2 | JTX User Pattern Octet 1, LSB | User test pattern least significant byte, Octet 1 |  |  |  |  |  |  |  | 0x00 |  |
| 0xA3 | JTX User Pattern Octet 1, MSB | User test pattern most significant byte, Octet 1 |  |  |  |  |  |  |  | 0x00 |  |
| 0xA4 | JTX User Pattern Octet 2, LSB | User test pattern least significant byte, Octet 2 |  |  |  |  |  |  |  | 0x00 |  |
| 0xA5 | JTX User Pattern Octet 2, MSB | User test pattern most significant byte, Octet 2 |  |  |  |  |  |  |  | 0x00 |  |
| 0xA6 | JTX User Pattern Octet 3, LSB | User test pattern least significant byte, Octet 3 |  |  |  |  |  |  |  | 0x00 |  |
| 0xA7 | JTX User Pattern Octet 3, MSB | User test pattern most significant byte, Octet 3 |  |  |  |  |  |  |  | 0x00 |  |
| 0xF5 | JTX converter mapping | JTX Converter 3:$\begin{aligned} & 0=\text { ADCA, } \\ & 1=\text { ADCB, } \\ & 2=\text { ADCC, } \\ & 3=\text { ADCD } \end{aligned}$ |  | $\begin{gathered} \hline \text { JTX Converter 2: } \\ 0=\text { ADCA, } \\ 1=\text { ADCB, } \\ 2=\text { ADCC, } \\ 3=\text { ADCD } \end{gathered}$ |  | $\begin{gathered} \text { JTX Converter 1: } \\ 0=\text { ADCA, } \\ 1=\text { ADCB, } \\ 2=\text { ADCC, } \\ 3=\text { ADCD } \end{gathered}$ |  | $\begin{gathered} \text { JTX Converter 0: } \\ 0=\text { ADCA, } \\ 1=\text { ADCB, } \\ 2=\text { ADCC, } \\ 3=\text { ADCD } \end{gathered}$ |  | 0xE4 |  |
| 0x100 | Resolution/ sample rate override | Open | Override enable | Resolution: <br> $0=16$ bits, <br> $1=14$ bits, <br> $2=12$ bits, <br> $3=10$ bits |  | Open | Sample rate: $001=40$ MSPS, $010=50 \mathrm{MSPS}$, $011=65$ MSPS, $100=80 \mathrm{MSPS}$, $101=105$ MSPS, $110=125$ MSPS |  |  | 0x00 | Sample rate override (requires transfer register, 0xFF). |
| 0x101 | User I/O Control 2 | Open | Open | Open | Open | Open | Open | Open | SDIO pull-down | 0x00 | Disables <br> SDIO <br> pull-down. |
| 0x102 | User I/O Control 3 | Open | Open | Open | Open | VCM powerdown | Open | Open | Open | 0x00 | VCM control. |


| Addr <br> (Hex) | Register Name | Bit 7 <br> (MSB) | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 (LSB) | Default Value (Hex) | Notes/ Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0x109 | Clock divider sync control | Clock divider sync mode: $0=$ use SYNC pin, 1 = use SYSREF $\pm$ pins | Reserved |  |  |  |  | Reset <br> clock <br> divider <br> sync <br> received | Sync clock divider enable: $0=$ <br> disabled, $1=$ enabled | 0x80 |  |
| 0x10A | Clock divider sync received | Open | Open | Open | Open | Open | Open | Open | Clock divider sync received | $0 \times 00$ | Read only. |

## MEMORY MAP REGISTER DESCRIPTIONS

For additional general information about functions controlled in Register 0x00 to Register 0xFF, see the AN-877 Application Note, Interfacing to High Speed ADCs via SPI.

## Device Index (Register 0x05)

Certain features in the map that are designated as local can be set independently for each channel, whereas other features apply globally to all channels (depending on context), regardless of the channel is selected. Bits[3:0] of Register 0x05 can select which data channels are affected.

## Transfer (Register 0xFF)

All registers except Register 0x100 are updated the moment they are written. Setting Bit 0 of the transfer register high invokes the settings in the resolution/sample rate override register (Address 0x100).

## Power Modes (Register 0x08)

## Bit 5-PDWN Pin Function

If set to 1 , the PDWN pin initiates standby mode. If set to 0 (cleared), the PDWN pin initiates full power-down mode.

## Bit 4-JTX Standby Mode

If set, the JTX block enters standby mode when chip standby is activated. Only the PLL is left running in standby mode. If cleared, the JTX block remains running when chip standby is activated.

## Bits[1:0]—Power Mode

In normal operation $(\operatorname{Bits}[1: 0]=00)$, all ADC channels and the JTX block are active.
In full power-down mode (Bits[1:0] = 01), all ADC channels and the JTX block are powered down, and the digital datapath clocks are disabled, while the digital datapath is reset. The outputs are disabled.

In standby mode (Bits[1:0] = 10), all ADC channels are partially powered down, and the digital datapath clocks are disabled. If JTX standby mode is set, the outputs are also disabled.
During a digital reset (Bits[1:0] = 11), all the digital datapath clocks and the outputs (where applicable) on the chip are reset, except for the SPI port.

Note that the SPI is always left under control of the user; that is, it is never automatically disabled or in reset (except by poweron reset). When the digital reset is deactivated, a foreground calibration sequence is initiated.

## Enhancement Control (Register 0x0C)

## Bit 2-Chop Mode

For applications that are sensitive to offset voltages and other low frequency noise, such as homodyne or direct conversion receivers, chopping in the first stage of the AD9656 is a feature that can be enabled by setting Bit 2 . In the frequency domain, chopping translates offsets and other low frequency noise to fcle $/ 2$ where it can be filtered.

## Output Mode (Register 0x14)

Bits[7:5]—JTX CS Mode
Defines the meaning of the JTX control bits.

## Bits[1:0]-Output Format

By default, this field is set to 1 for data output in twos complement format. Setting this field to 0 changes the output mode to offset binary.

## Clock Phase Control (Register 0x16)

## Bits[6:4]—Input Clock Phase Adjust

When the clock divider (Register 0x0B) is used, the applied clock is at a higher frequency than the internal sampling clock. Bits[6:4] determine at which phase the external clock sampling occurs. This is only applicable when the clock divider is used. Setting Bits[6:4] greater than Register 0x0B, Bits[2:0] is prohibited.

Table 20. Input Clock Phase Adjust Options

| Input Clock Phase Adjust, Bits[6:4] | Number of Input Clock <br> Cycles of Phase Delay |
| :--- | :--- |
| 000 (default) | 0 |
| 001 | 1 |
| 010 | 2 |
| 011 | 3 |
| 100 | 4 |
| 101 | 5 |
| 110 | 6 |
| 111 | 7 |

## JTX User Pattern (Register 0xA0 to Register 0xA7)

The pattern in these registers is output on all active lanes when Register 0x61, Bits[3:0] are set to 5 or 6 . A 32-bit pattern, the concatenation of Register 0xA0, Register 0xA2, Register 0xA4, and Register 0xA6 is inserted before the scrambler if Register 0x61, Bits[5:4] are set to 2. If Register 0x61, Bits[5:4] are set to 1 (a 40-bit pattern), the concatenation of Register 0xA1, Bits[1:0] and Register 0xA0, Bits[7:0]; Register 0xA3, Bits[1:0] and Register 0xA2, Bits[7:0]; Register 0xA5, Bits[1:0] and Register 0xA4, Bits[7:0]; Register 0xA7, Bits[1:0] and Register 0xA6, Bits[7:0] is inserted after the 8b/10b encoder.

## Resolution/Sample Rate Override (Register 0x100)

This register allows the user to downgrade the resolution and/or the maximum sample rate (for lower power) in applications that do not require full resolution and/or sample rate. Settings in this register are not initialized until Bit 0 of the transfer register (Register 0xFF) is written high.

Bits[2:0] do not affect the sample rate; they affect the maximum sample rate capability of the ADC.
Writing to Register 0x100 reverts other registers to defaults. If nondefault configurations are desired, write to Register 0x100 first, and then perform other desired SPI operations to preserve the desired configuration.

## User I/O Control 2 (Register 0x101)

Bit 0-SDIO Pull-Down
Bit 0 can be set to disable the internal $30 \mathrm{k} \Omega$ pull-down resistor on the SDIO pin. This setting can limit the loading when many devices are connected to the SPI bus.

## User I/O Control 3 (Register 0x102)

Bit 3-VCM Power-Down
Bit 3 can be set high to power down the internal VCM generator. This feature is used when applying an external reference.

## APPLICATIONS INFORMATION

## DESIGN GUIDELINES

Before starting system level design and layout of the AD9656, it is recommended that the designer become familiar with these guidelines, which discuss the special circuit connections and layout requirements needed for certain pins.

## POWER AND GROUND RECOMMENDATIONS

When connecting power to the AD9656, it is recommended to use separate 1.8 V supplies: one supply for analog (AVDD), a separate shared supply for the digital outputs (DRVDD), and the digital (DVDD). DRVDD must be kept at the same voltage as DVDD. SVDD can be shared with any of the other supplies if 1.8 V SPI operation is desired. The designer can use several different decoupling capacitors to cover both high and low frequencies. Locate these capacitors close to the point of entry at the PCB level and close to the pins of the device with minimal trace length.
When using the AD9656, a single PCB ground plane is sufficient. With proper decoupling and smart partitioning of the PCB analog, digital, and clock sections, optimum performance is easily achieved.

## CLOCK STABILITY CONSIDERATIONS

When powered on, the AD9656 enters an initialization phase during which an internal state machine sets up the biases and the registers for proper operation. During the initialization process, the AD9656 requires a stable clock. If the ADC clock source is not present or not stable during ADC power-up, it disrupts the state machine and causes the ADC to start up in an unknown state. To correct this, an initialization sequence must be reinvoked after the ADC clock is stable by issuing a digital reset via Register 0x08. In the default configuration (internal $\mathrm{V}_{\text {REF }}$, ac-coupled input) where $\mathrm{V}_{\text {REF }}$ and $\mathrm{V}_{\mathrm{CM}}$ are supplied by the ADC itself, a stable clock during power-up is sufficient. In the case where $\mathrm{V}_{\text {ReF }}$ and/or $\mathrm{V}_{\mathrm{CM}}$ are supplied by an external source, these, too, must be stable at power-up; otherwise, a subsequent digital reset via Register $0 \times 08$ is needed. Interruption of the sample clock during operation and changes in sample rate also necessitate a digital reset. The pseudo code sequence for a digital reset is as follows:
$\begin{array}{ll}\text { SPI_Write }(0 \times 08,0 \times 03) ; & \text { \# Digital Reset } \\ \text { SPI_Write (0x08, 0x00); } & \text { \# Normal Operation }\end{array}$

## EXPOSED PAD THERMAL HEAT SLUG RECOMMENDATIONS

It is mandatory that the exposed pad on the underside of the ADC connect to analog ground (AGND) to achieve the best electrical and thermal performance. A continuous, exposed (no solder mask) copper plane on the PCB must mate to the AD9656 exposed pad, Pin 0.
The copper plane must have several vias to achieve the lowest possible resistive thermal path for heat dissipation to flow through the bottom of the PCB. Fill or plug these vias with nonconductive epoxy.
To maximize the coverage and adhesion between the ADC and the PCB, overlay a silkscreen to partition the continuous plane on the PCB into several uniform sections. This partitioning prevents the solder from pooling and provides several tie points between the ADC and the PCB during the reflow process. Using one continuous plane with no partitions guarantees only one tie point between the ADC and the PCB. See the evaluation board for a PCB layout example. For detailed information about the packaging and PCB layout of chip scale packages, refer to the AN-772 Application Note, A Design and Manufacturing Guide for the Lead Frame Chip Scale Package (LFCSP).

## VCM

Decouple the VCM pin to ground with a $0.1 \mu \mathrm{~F}$ capacitor.

## REFERENCE DECOUPLING

Externally bypass the VREF pin to ground with a low ESR, $1.0 \mu \mathrm{~F}$ capacitor in parallel with a low ESR, $0.1 \mu \mathrm{~F}$ ceramic capacitor.

## SPI PORT

When the full dynamic performance of the converter is required, do not activate the SPI port. Because the SCLK, CSB, and SDIO signals are typically asynchronous to the ADC clock, noise from these signals can degrade converter performance. If the on-board SPI bus is used for other devices, it may be necessary to provide buffers between this bus and the AD9656 to keep these signals from transitioning at the converter input pins during critical sampling periods.

## OUTLINE DIMENSIONS



FOR PROPER CONNECTION OF THE EXPOSED PAD, REFER TO THE PIN CONFIGURATION AND FUNCTION DESCRIPTIONS SECTION OF THIS DATA SHEET.
*COMPLIANT TO JEDEC STANDARDS MO-220-WLLD-5 WITH EXCEPTION TO EXPOSED PAD DIMENSION.
Figure 75. 56-Lead Lead Frame Chip Scale Package [LFCSP_WQ]
$8 \mathrm{~mm} \times 8 \mathrm{~mm}$ Body, Very Very Thin Quad (CP-56-9)
Dimensions shown in millimeters

## ORDERING GUIDE

| Model $^{1}$ | Temperature Range | Package Description | Package Option |
| :--- | :--- | :--- | :--- |
| AD9656BCPZ-125 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 56-Lead Lead Frame Chip Scale Package [LFCSP_WQ] | CP-56-9 |
| AD9656BCPZRL7-125 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 56-Lead Lead Frame Chip Scale Package [LFCSP_WQ] | CP-56-9 |
| AD9656EBZ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Evaluation Board |  |

[^2]
## NOTES

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components
Click to view similar products for Data Conversion IC Development Tools category:
Click to view products by Analog Devices manufacturer:
Other Similar products are found below :
EVAL-AD5063EBZ EVAL-AD5422LFEBZ EVAL-AD7265EDZ EVAL-AD7641EDZ EVAL-AD7674EDZ EVAL-AD7719EBZ EVAL-AD7767-1EDZ EVAL-AD7995EBZ AD9114-DPG2-EBZ AD9211-200EBZ AD9251-20EBZ AD9251-65EBZ AD9255-125EBZ AD9284250EBZ AD9613-170EBZ AD9627-125EBZ AD9629-20EBZ AD9709-EBZ AD9716-DPG2-EBZ AD9737A-EBZ AD9787-DPG2-EBZ AD9993-EBZ DAC8555EVM ADS5482EVM ADS8372EVM EVAL-AD5061EBZ EVAL-AD5062EBZ EVAL-AD5443-DBRDZ EVALAD5570SDZ EVAL-AD7450ASDZ EVAL-AD7677EDZ EVAL-AD7992EBZ EVAL-AD7994EBZ AD9119-MIX-EBZ AD9148-M5375EBZ AD9204-80EBZ AD9233-125EBZ AD9265-105EBZ AD9265-80EBZ AD9608-125EBZ AD9629-80EBZ AD9648-125EBZ AD964920EBZ AD9650-80EBZ AD9765-EBZ AD9767-EBZ AD9778A-DPG2-EBZ ADS8322EVM LM96080EB/NOPB EVAL-AD5445SDZ


[^0]:    ${ }^{1}$ See the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation, for definitions and for details on how these tests were completed.
    ${ }^{2}$ Measured with a low input frequency, full-scale sine wave on all four channels.
    ${ }^{3}$ Standby can be controlled via the SPI.

[^1]:    See the AN-835 Application Note, Understanding High Speed ADC Testing and Evaluation, for definitions and for details on how these tests were completed
    ${ }^{2}$ Measured with a low input frequency, full-scale sine wave on all four channels.
    ${ }^{3}$ Standby can be controlled via the SPI.

[^2]:    ${ }^{1} Z=$ RoHS Compliant Part.

